

DVD RECEIVER AMP

Basic Model: HT-X30/X40

* Application: HT-X30/TX35/KX30/TKX35

HT-X40

www.electronicsrepair.net

SERVICE Manual

DVD RECEIVER AMP SYSTEM



Features

- * Multi-Disc Playback & FM Tuner
- * DVD-Audio compatible
- * USB HOST Function support
- * Dolby Pro Logic II
- * DTS (Digital Theater Systems)
- * TV Screen Saver Function
- * Power Saving Function
- * Customized TV Screen Display
- * Anynet+ Function
- * Optional Wireless receiver amplifier

INDEX

Ch1	Precautions	: Ch9	Block Diagram
Safety Preca	utions1-1	Block	9-1
Servicing Pre	ecautions1-2		
Precautions t	for Electrostatically		
Sensitive Dev	vice (ESDs 1-3	: Ch10	Wiring Diagram
Special Prec	autions and Warning	Wiring Diag	gram 10- 1
Lables for La	ser Products1-4	•	
Special Prec	autions for HDD1-5	•	
Ch2	Product Description	Ch11	
		PCB FRON	VT11-1
		PCB MAIN	11-2
	2-2	PCB AMP.	11-3
Accessories .		PCB SMPS	S11-4
		•	
Ch3	Product Functions	•	
	tion3-1	Ch12	Schematic Diagram
	ons 3-2		12-1
New Functio	ns 3-3	•	12-6
Ob 4	Adimeteranta	•	
The second secon	Adjustments	•	12-7
DVD flash In	itialization & Update4-1	• SMPS	12-8
_		•	
Ch5	How to disassemble	Ch13	Circuit Board Description
How to disas	ssemble 5-1	•	•
		Circuit Layo	out and Functions (HT-X30) 13- 1
Ch6	TroubleShooting	The Function	ons of each Board13-4
Main	6-1	•	
	ke when Protection is enabled.6-2	•	
		•	
Ch7 I	Empleyed Views and Barta Ust	• • •	
Ch7	Exploded Views and Parts List	•	
Total Explod	ed View 7-1	•	
		•	
Ch8	Electrical Parts List	•	
Electrical Par		• •	

1. Precautions

Follow these safety, servicing and ESD precautions to prevent damage and protect against potential hazards such as electrical shock and X-rays.

1-1 Safety Precautions

- 1. Be sure that all of the built-in protective devices are replaced.
- When reinstalling the chassis and its assemblies, be sure to restore all protective devices, including control knobs and compartment covers.
- 3. Make sure that there are no cabinet openings through which people-particularly children-might insert fingers and contact dangerous voltages. Such openings include the spacing between the picture tube and the cabinet mask, excessively wide cabinet ventilation slots, and improperly fitted back covers.
- 4. Design Alteration Warning: Never alter or add to the mechanical or electrical design of the unit. Example: Do not add auxiliary audio or video connectors. Such alterations might create a safety hazard. Also, any design changes or additions will void the manufacturer's warranty.
- Leakage Current Hot Check (Figure 1-1):
 Warning: Do not use an isolation
 transformer during this test. Use a leakage current tester or a metering system that
 complies with American National Standards
 Institute (ANSI C101.1, Leakage Current for
 Appliances), and Underwriters Laboratories
 (UL Publication UL1410, 59.7).

With the unit completely reassembled, plug the AC line cord directly into a 120V AC outlet. With the unit's AC switch first in the ON position and then OFF, measure the current between a known earth ground (metal water pipe, etc.) and all exposed metal parts. Examples: Handle brackets, metal cabinets, screwheads and control shafts. The current measured should not exceed 0.5 milliamp. Reverse the power-plug prongs in the AC outlet and repeat.

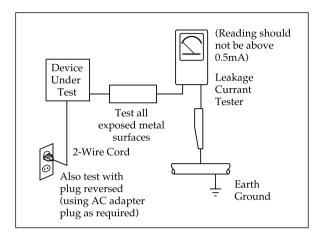


Fig. 1-1 AC Leakage Test

6. Insulation Resistance Cold Check: (1) With the unit's AC plug disconnected from the AC source, connect an electrical jumper across the two AC prongs. (2) Set the power switch to ON. (3) Measure the resistance between the shorted AC plug and any exposed metallic parts. Example: Screwheads, antenna, control shafts or handle brackets.

If any of the exposed metallic parts has a return path to the chassis, the measured resistance should be between 1 and 5.2 megohms. If there is no return path, the measured resistance should be "infinite." If the resistance is outside these limits, a shock hazard might exist. See Figure 1-2

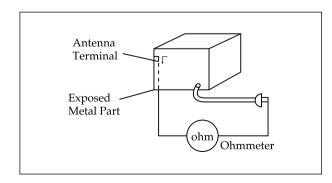


Fig. 1-2 Insulation Resistance Test

Samsung Electronics 1-1

1-1 Safety Precautions (Continued)

- 7. Components, parts and wiring that appear to have overheated or that are otherwise damaged should be replaced with parts that meet the original specifications. Always determine the cause of damage or overheating, and correct any potential hazards
- 8. Observe the original lead dress, especially near the following areas: Antenna wiring, sharp edges, and especially the AC and high voltage power supplies. Always inspect for pinched, out-of-place, or frayed wiring. Do not change the spacing between components and the printed circuit board. Check the AC power cord for damage. Make sure that no wires or components touch thermally hot parts.
- 9. Product Safety Notice:
 Some electrical and mechanical parts
 have special safety-related characteristics
 which might not be obvious from visual
 inspection. These safety features and the
 protection they give might be lost if the
 replacement component differs from the
 original--even if the replacement is rated
 for higher voltage, wattage, etc.
- 10 Components that are critical for safety are indicated in the circuit diagram by shading, A or A . Use replacement components that have the same ratings, especially for flame resistance and dielectric strength specifications. A replacement part that does not have the same safety characteristics as the original might create shock, fire or other hazards.

1-2 Servicing Precautions

Warning1: First read the "Safety Precautions" section of this manual. If some unforeseen circumstance creates a conflict between the servicing and safety precautions, always follow the safety precautions.

- 1. Servicing precautions are printed on the cabinet. Follow them.
- 2. Always unplug the unit's AC power cord from the AC power source before attempting to: (a) Remove or reinstall any component or assembly, (b) Disconnect an electrical plug or connector, (c) Connect a test component in parallel with an electrolytic capacitor.
- 3. Some components are raised above the printed circuit board for safety. An insulation tube or tape is sometimes used. The internal wiring may be clamped to prevent contact with thermally hot components. Reinstall all such elements to their original position.
- 4. After servicing, always check that the screws, components and wiring have been correctly reinstalled. Make sure that the portion around the serviced part has not been damaged.

- 5. Check the insulation between the blades of the AC plug and accessible conductive parts (examples: metal panels, input terminals and earphone jacks).
- 6. Insulation Checking Procedure: Disconnect the power cord from the AC source and turn the power switch ON. Connect an insulation resistance meter (500V) to the blades of the AC plug.
 - The insulation resistance between each blade of the AC plug and accessible conductive parts (see above) should be greater than 1 megohm.
- 7. Never defeat any of the B+ voltage interlocks. Do not apply AC power to the unit (or any of its assemblies) unless all solid-state heat sinks are correctly installed.
- 8. Always connect a test instrument's ground lead to the instrument chassis ground *before* connecting the positive lead; always remove the instrument's ground lead last.

1-2 Samsung Electronics

1-3 Precautions for Electrostatically Sensitive Devices (ESDs)

- 1. Some semiconductor ("solid state") devices are easily damaged by static electricity. Such components are called Electrostatically Sensitive Devices (ESDs). Examples include integrated circuits and some field-effect transistors. The following techniques will reduce the occurrence of component damage caused by static electricity.
- 2. Immediately before handling any semiconductor components or assemblies, drain the electrostatic charge from your body by touching a known earth ground. Alternatively, wear a discharging wrist-strap device. (Be sure to remove it prior to applying power--this is an electric shock precaution.)
- 3. After removing an ESD-equipped assembly, place it on a conductive surface such as aluminum foil to prevent accumulation of electrostatic charge.
- 4. Do not use freon-propelled chemicals.

 These can generate electrical charges that damage ESDs.

- 5. Use only a grounded-tip soldering iron when soldering or unsoldering ESDs.
- Use only an anti-static solder removal device. Many solder removal devices are not rated as "anti-static" (these can accumulate sufficient electrical charge to damage ESDs).
- 7. Do not remove a replacement ESD from its protective package until you are ready to install it. Most replacement ESDs are packaged with leads that are electrically shorted together by conductive foam, aluminum foil or other conductive materials.
- 8. Immediately before removing the protective material from the leads of a replacement ESD, touch the protective material to the chassis or circuit assembly into which the device will be installed.
- Minimize body motions when handing unpackaged replacement ESDs. Motions such as brushing clothes together, or lifting a foot from a carpeted floor can generate enough static electricity to damage an ESD.

1-4 Special Precautions and Warning Labels for Laser Products

(UL)

(CSA)

(UL,CSA,EU)

CERTIFIED ONLY TO CANADIAN ELECTRICAL CODE.

Chapter J.At date of Manufacture

CERTIFIE EN VERTU DU CODE CANADIAN DE LELETRICITE SEULEMENT

(UL,CSA,EU)

(UL,CSA,EU)

CLASS 1

LASER PRODUCT

Fig. 1-3 Warning Labels (Location: Enclosure Block)

(UL,CSA,SCAN)

CAUTION: INVISIBLE LASER RADIATION WHEN OPEN AND INTERLOCKS DEFEATED AVOIDEXPOSURE TO BEAM ADVARSEL: USYNLIG LASERSTRÁLING VED ABNING NÁR SIKKERHEDSAFBRYDERE ER UDE AF FUNKTION UNDGA UDSAETTELSE FOR STRALING VARO: AUSTAUTTAESSA JA SUDJALUKTUS OHITETTAESSA OLET ALTINA NAKYMATTOMALLE LASERSATEILYLLE ALA KATSO SATEESEENI VARNING:OSYNLIG LASERSTRÁLNING NAR DENNA DEL AR OPPNAD OCH SPARREN AR URKOPPLAD BETRAKTA EJSTRÁLENI

(EU)



UL : Manufactured for U.S.A. Market.CSA : Manufactured for Canadian Market.EU : Manufactured for European Market.

SCAN : Manufactured for Scandinavian

Market.

Fig. 1-4 Warning Labels (Location: Disc Clamper, Inner Side of Unit Door or Nearby Unit Chassis)

Samsung Electronics 1-3

1-4 Special Precautions and Warning Labels for Laser Products (Continued)

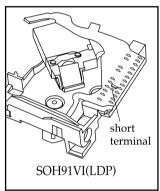
1-4-1 Warnings

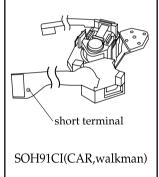
- 1. When servicing, do not approach the LASER exit with the eye too closely. In case it is necessary to confirm LASER beam emission, be sure to observe from a distance of more than 30 cm from the surface of the objective lens on the optical pick-up block.
- 2. Do not attempt to handle the objective lens when the DISC is not on the tray.

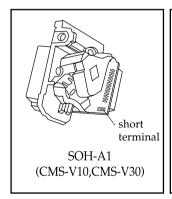
1-4-2 Laser Diode Specifications

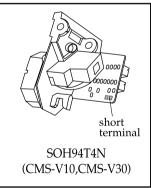
Material: GaAs+ GaAlAs Wavelength: 760-800 nm Emission Duration: Continuous

Laser Output: 0.2 mw (measured at a 1.6 mm distance from the objective lens surface on the optical pick-up block.)



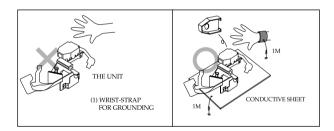






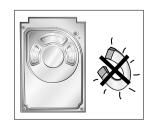
1-4-3 Handling the Optical Pick-up

- 1. Static electricity from clothing or the body may cause electrostatic breakdown of the laser diode in the Optical Pickup. Follow this procedure:
- Place a conductive sheet on the work bench (i.e., the black sheet used for wrapping repair parts.) Note: The surface of the work bench should be covered by a copper ground plane, which is grounded.
- 3. The repair technician must wear a wrist strap which is grounded to the copper sheet.
- 4. To remove the Optical Pickup block: Place the set on the conductive sheet, and momentarily touch the conductive sheet with both hands. (While working, do not allow any electrostatic sources--such as clothes--to touch the unit.)
- 5. Ground the "Short Terminal" (located on the PCB, inside the Pickup Assembly) before replacing the Pickup. This terminal should be shorted whenever the Pickup Assembly is lifted or moved.
- 6. After replacing the Pickup, reopen the Short Terminal. See diagrams below:



1-5 Special Precautions for HDD

- * HDD Data Maintenance Step
- 1. Since the data on the HDD is weak to mechanical shock, place the HDD in a safe location that is free from mechanical shock once it is removed from the main unit.
- 2. In order to safe keep the data on the HDD, back up the data before the repair or make sure not to place the HDD near any electrical appliance that generates a strong magnetic field.



1-4 Samsung Electronics

2. Product Description

1. Features

	Features
Multi-Disc Playback & FM Tuner	The HT-X30/HT-TX35 combines the convenience of multi-disc playback capability, including DVD-AUDIO, DVD-VIDEO, VCD, CD, MP3-CD, WMA-CD, DivX, CD-R/RW, and DVD-R/RW, with a sophisticated FM tuner, all in a single player.
DVD-Audio compatible	Experience the super high-quality audio performance of DVD-Audio. The on-board 24-bit/192kHz DAC enables this player to deliver exceptional sound quality in terms of dynamic range, low-level resolution and high-frequency detail.
USB HOST Function support	You can connect and play files from external USB storage devices such as MP3 players, USB flash memory, etc. using the Home Theater's USB HOST function.
Dolby Pro Logic II	Dolby Pro Logic II is a new form of multi-channel audio signal decoding technology that improves upon existing Dolby Pro Logic.
DTS (Digital Theater Systems)	DTS is an audio compression format developed by Digital Theater Systems Inc. It delivers full-frequency 5.1 channel sound.
TV Screen Saver Function	The HT-X30/HT-TX35 automatically brightens and darkens your TV screen after 3 minutes in the stop mode. The HT-X30/HT-TX35 automatically switches itself into the power saving mode after 20 minutes in the screen saver mode.
Power Saving Function	The HT-X30/HT-TX35 automatically shuts itself off after 20 minutes in stop mode.
Customized TV Screen Display	The HT-X30/HT-TX35 allows you to select your favorite image during JPEG, DVD or VCD playback and set it as your background wallpaper.
Anynet+ Function	Anynet+ is a function that can be used to operate the main unit using a Samsung TV remote control, by connecting the Home Theater to a SAMSUNG TV using an HDMI Cable. (This is only available with SAMSUNG TVs that support Anynet+.)
Optional Wireless receiver amplifier	Samsung's optional rear-channel wireless module does away with cables running between your DVD receiver and rear-channel speakers. Instead, the rear speakers connect to a compact wireless module that communicates with your DVD receiver.

Samsung Electronics 2-1

HT-X30

	Speaker system	5.1ch speaker system			
	Opeaker system	Front/Center/Rear speaker		Subwoofer speaker	
S	Impedance	3Ω x 5		3Ω	
P	Frequency range	145Hz~2	20KHz	35Hz~155Hz	
Ε	Output sound pressure level	86dB/W/M		86dB/W/M	
Α	Rated input	133W		135W	
K	Maximum input	266W		270W	
E R	Dimensions (W x H x D)	Front/Rear	90 x 168x 95 mm	180 x 320 x 390 mm	
IX	Differsions (WXTTXD)	Center	250 x 90 x 95 mm	100 X 020 X 030 Hilli	
	Weights	Front/Rear	0.6 Kg/0.5 Kg	5.5 kg	
	vveignis	Center	0.7 Kg	0.0 Ng	

HT-TX35

	Speaker system		5.1ch speaker system		
	Opeaker system	Front/Ce	nter/Rear speaker	Subwoofer speaker	
S	Impedance	3Ω x 5		3Ω	
P	Frequency range	140Hz~2	20KHz	35Hz~160Hz	
Е	Output sound pressure level	82dB/W/	M	85dB/W/M	
Α	Rated input	80W		100W	
K	Maximum input	160W		200W	
E R	Dimensions (W x H x D)	Front	90 x 1145 x 90 mm		
IX	Difficusions (WXTTXD)	Rear	90 x 1145 x 90 mm	198 x 400 x 338 mm	
		Center	300 x 90 x 92 mm		
	Weights	Front/Rear	3.5Kg/3.2Kg	6.1Kg	
	VVeigitis	Center	1.2Kg	U. ING	

2-2 Samsung Electronics

3. Accessories

Commodity Photo	Commodity Name	Materials Cord
	Remote Control	AH59-01778E
	FM Antenna	AH42-00021A

Samsung Electronics 2-3

4. Specification Comparison

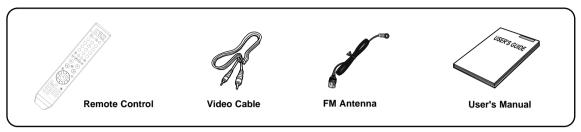
Model Name	X30	Q20
Year	2007	2006
OUTPUT	800W	500W
5.1 CH	0	О
USB HOST	0	0
HDMI OUT	0	x
HDMI CEC	0	х

2-4 Samsung Electronics

3. Product Functions

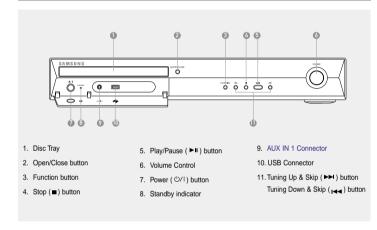
1. SPK connection

Accessories

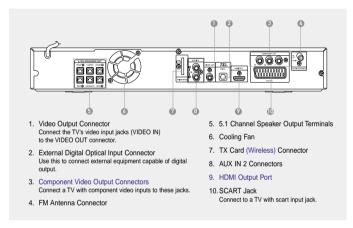


Description

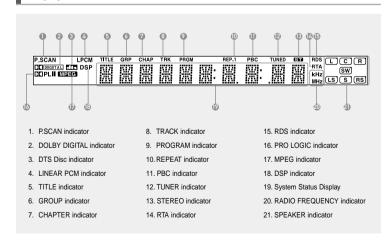
Front Panel



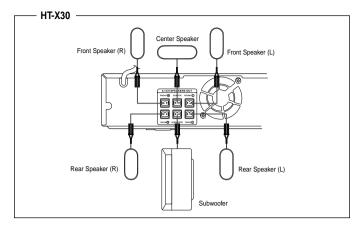
Rear Panel



Display



Samsung Electronics 3-1



Position of the DVD Player

· Place it on a stand or cabinet shelf, or under the TV stand

Front Speakers **D**®

- Place these speakers in front of your listening position, facing inwards (about 45°) toward you.

 Place the speakers so that their tweeters will be at the same
- height as your ear.
 Align the front face of the front speakers with the front face of the center speaker or place them slightly in front of the center

Center Speaker G

- . It is best to install it at the same height as the front speakers You can also install it directly over or under the TV.

Selecting the Listening Position

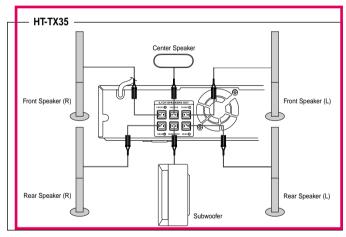
The listening position should be located about 2.5 to 3 times the distance of the TV's screen size away from the TV. Example :
For 32" TVs 2~2.4m (6~8feet) For 55" TVs 3.5~4m (11~13feet)



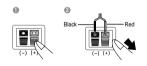
- Place these speakers behind your listening position.
 If there isn't enough room, place these speakers so they face
- there isn't enough routh, place those speakers so start, a ach other. lace them about 60 to 90cm (2 to 3feet) above your ear,
- facing slightly downward.
- * Unlike the front and center speakers, the rear speakers are used to handle mainly sound effects and sound will not come from them all the time.

Subwoofer 600

 The position of the subwoofer is not so critical. Place it anywhere vou like.



Connecting the Speakers



- 1 Press down the terminal tab on the back of the speaker.
- 2 Insert the black wire into the black terminal (-) and the red wire into the red (+) terminal, and then release the tab.
- ${f 3}$ Connect the correct color speaker cable to the same color speaker output terminal on the rear of the subwoofer,
 - according to the polarity markings (+/-).

 Example: Connect the green center speaker cable to the green center speaker output terminal on the rear of the subwoofer according to the polarity markings (+/-).



• Do not let children play with or near the speakers. They could get hurt if a speaker falls.
• When connecting the speaker wires to the speakers, make sure that the polarity (+/-) is correct

- · Keep the subwoofer speaker out of reach of children so as to prevent children from inserting their hands or alien
- substances into the duct (hole) of the subwoofer speaker.

 Do not hang on the wall through the duct (hole).



. If you place a speaker near your TV set, screen color may be distorted because of the magnetic field generated by the speaker. If this occurs, place the speaker away from your TV set.

2. Main Functions

(b) ... (b)



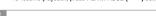




- Place a disc gently into the tray with the disc's label facing up.
- 3 Close the compartment by pressing the OPEN/CLOSE button again.
 - Playback starts automatically



- If pressed once, <PRESS PLAY> is displayed and the stop position will be stored in memory.
- If PLAY/PAUSE (▶■) button or ENTER button is pressed, playback resumes from the stop position. (This function works only with DVDs.)
- If pressed twice, <STOP> is displayed, and if PLAY/PAUSE (▶■) button is pressed, playback starts from the beginning.
- To temporarily pause playback, press PLAY/PAUSE (>II) button during playback.
 - To resume playback, press PLAY/PAUSE (►II) button again.





. Avoid getting fingerprints on the writing surface of a disc. It may cause the disc to not read properly



- Depending on the content of the disc, the initial screen may appear different.
 Any piracy could not be runnable in the player. Otherwise, it violates the CSS recommendations

What is CSS (Content Scrambling System)?

The CSS is a copy protection device that prevents the content of a DVD from being copied into the HDD of the PC as it is, unlike other media, executable directly from the PC. And it is also a data decryption system that decrypts the key encryption with the encrypted title key (of the DVD title) and the player key (of the DVD player).

Selecting Audio/Subtitle Language

Audio Language Selection Function





- $\boldsymbol{2}$ Press Cursor \blacktriangle , \blacktriangledown buttons or numeric buttons to select the desired
 - Depending on the number of languages on a DVD disc, a different audio language (ENGLISH, SPANISH, FRENCH, etc.) is selected each time the button is pressed



Subtitle Language Selection Function





- 1 Press INFO button twice.
- 2 Press Cursor ▶ button to move to SUBTITLE (🖃) display.
- 3 Press Cursor ▼ button or numeric buttons to select the desired subtitle.





- To operate this function, you can also press the Select AUDIO or Select SUBTITLE buttons on the remote control.
- Depending on the disc, the Subtitle and Audio Language functions may not be available.

3-2 Samsung Electronics

Using Disc Menu

You can use the menus for the audio language, subtitle language, profile, etc.



- 1 In Stop mode, press MENU button.
 - When playing a VCD (version 2.0), this toggles between <MENU ON> and <MENU OFF>
- 2 Press Cursor ▲, ▼ buttons to move to <DISC MENU> and then press ENTER button
 - When you select Disc Menu and it is not supported by the disc, the <This menu is not supported> message appears on the screen
- 3 Press Cursor \blacktriangle , \blacktriangledown , \blacktriangleleft , \blacktriangleright buttons to select the desired item.
- 4 Press ENTER button.
- > Press MENU button to exit the setup screen.

When playing a VCD (version 2.0), you can select and view various scenes according to the menu

- MENU ON: This VCD disc is version 2.0. The disc is played back according to the menu screen. Some functions may be disabled. When some functions are disabled, select MENU OFF: This VCD disc is version 1.1. The disc is played back in the same way as with a



Disc menu display may be different depending on the disc.

Using the Title Menu



For DVDs containing multiple titles, you can view the title of each movie. Depending on the disc, the availability of this



- 1 In Stop mode, press MENU button.
- 2 Press Cursor ▲, ▼ button to move to <Title Menu>.
- 3 Press ENTER hutton
- The title menu appears
- > Press MENU button to exit the setup screen.





3. New Functions





Skip Forward/Back

During playback, press the I◄◄, ▶▶I button.

- Goes to the next file whenever you press ▶▶ button, if there are over 2 files in the disc.
- Goes to the previous file whenever you press I button, if there are over 2 files in the disc.

Fast playback

■ Each time you press either button, the playback speed will change as follows: 2x → 4x → 8x → 32x → Normal.

5 Minute Skip function

During playback, press the ◀ . ▶ button.

- Playback skips 5 minutes forward whenever you press ▶ button.
- Playback skips 5 minutes back whenever you press ◀ button



Zoom Function

- 1 Press ZOOM button.
 - Each time you press the button, your selection will toggle between <ZOOM X2> and <ZOOM OFF>.
- 2 Press Cursor ▲, ▼, ◀, ▶ buttons to move to the area you want to enlarge.



• DivX file can be zoomed only in ZOOM X2 mode.

DivX files have .Avi file extensions, however, not all .Avi files are DivX and may not be playable in this unit.



Audio Display

- If there are multiple audio tracks on a disc, you can toggle between them
- Each time you press the button, your selection will toggle between <AUDIO (1/N, 2/N ...)> and ()





Subtitle Display

Press the SUBTITLE button

- Each time you press the button, your selection will toggle between <SLIRTITLE (1/N, 2/N,)>
- If the disc has only one subtitle file, it will be played automatically.
- See number 2 (Caption Function) below for more details concerning Subtitle usage with DivX



If the disc has more than one subtitle file

If the disc has more than one subtitle file, the default subtitle may not match the movie and you will have to select your subtitle language as follow

- 1 In Stop mode, press the ▲, ▼ button, select the desired subtitle (🔙) from the TV screen, and then press the ENTER button.
- 2 When you select the desired DivX file from the TV screen, the movie will be

DivX(Digital internet video eXpress)

DivX is a video file format developed by Microsoft and is based on MPEG4 compression technology to provide audio and video data over the Internet in real-tin

MPEG4 is used for video encoding and MP3 for audio encoding so that the users can watch a movie at near DVD-quality video and audio.

This product only supports the following media formats. If both video and audio formats are not supported, the user may experience problems such as broken images or no sound.

Format	AVI	`WMV	
Supported Versions	DivX3.11~DivX5.1, XviD	V1/V2/V3/V7	

Supported Audio Formats

Format	MP3	WMA	AC3	DTS
Bit Rate	80~384kbps	56~128kbps	128~384kbps	1.5Mbps
Sampling Frequency	44.1khz		44.1/48khz	44.1khz

- DivX files, including audio and video files, created in the DTS format can only support up to 6Mbps
- Aspect Ratio: Although default DivX resolution is 640x480 pixels (4:3), this product supports up to 800x600 pixels (16:9). TV screen resolutions higher than 800 will not be supported.
 When you play a disc whose sampling frequency is higher than 48khz or 320kbps, you may experience shaking
- on the screen during playback.

2. Caption Function

- You must have some experience with video extraction and editing in order to use this feature properly.
- To use the caption function, save the caption file (*.smi) in the same file name as that of the DivX media file (*.avi) within the same folder.

Example. Root Samsung_007CD1.avi

Samsung_007CD1.smi
• Up to 60 alphanumeric characters or 30 East Asian characters (2 byte characters such as Korean and Chinese) for the

Samsung Electronics

Setting TV Screen type

Depending on your TV type (Wide Screen or conventional 4:3), you can select the TV's aspect ratio.



- 1 In Stop mode, press MENU button
- 2 Press Cursor ▼ button to move to <Setup> and then press ENTER button.
- 3 Press Cursor ▼ button to move to <TV DISPLAY> and then press ENTER button
- 4 Press Cursor ▲, ▼ button to select the desired item and then press ENTER button.
 - Once the setup is complete, you will be taken to the previous screen.
- > Press RETURN button to return to the previous level
- > Press MENU button to exit the setup screen

Adjusting the TV Aspect Ratio (Screen Size)

The horizontal to vertical screen size ratio of conventional TVs is 4:3, while that of widescreen and high definition TVs is 16:9. This ratio is called the aspect ratio. When playing DVDs recorded in different screen sizes, you should adjust the aspect ratio to fit your TV or monitor.

For a standard TV, select either <4:3LB> or <4:3PS> option according to personal preference. Select "16:9" if you have a widescreen TV.



Select this to view a 16:9 picture in the full-screen mode on your widescreen TV.

You can enjoy the widescreen aspect.



Select this to play a 16:9 picture in the letter box mode on a conventional TV. Black bars will appear at the top and bottom of the screen





Select this to play a 16:9 picture in the pan & scan mode on a conventional TV.
 You can see the central portion of the screen only (with the sides of the 16:9 picture cut off)



- If a DVD is in the 4:3 ratio, you cannot view it in widescreen.
 Since DVD discs are recorded in various image formats, they will look different depending on the software, the type of TV, and the TV aspect ratio setting.

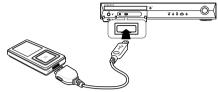
Playing Media Files using the USB HOST feature

You can enjoy media files such as pictures, movies and music saved in an MP3 player, USB memory or digital camera in high quality video with 5.1 channel home theater sound by connecting the storage device to the USB port of the home theater





1 Connect the USB device to the USB port on the front of the unit.



- 2 Press the FUNCTION button on the main unit or the USB button on the remote control to select the USB mode.
- <USB> appears on the display screen and then disappears.
- USB MENU screen appears on the TV screen and the saved file is played.
- 3 To stop playback, press the STOP (■) button.
- > Safe LISB Removal

To prevent damage to the memory stored in the USB device, perform safe removal before disconnecting the USB cable.

- (1) Press the STOP (■) button twice in a row. The display will show REMOVE USB.
- (2) Remove the USB cable.

Skip Forward/Back



During playback, press the I◄◄ ▶►I button.

- When there is more than one file, when you press the ▶▶ button, the next file is selected.
- When there is more than one file, when you press the I◄ button, the previous file is selected

Fast playback



To play back the disc at a faster speed, press ◀◀▶▶ button during playback.

■ Each time you press either button, the playback speed will change as follows: 2x → 4x → 8x → 32x → Normal.

Compatible Devices

- 1. USB devices that support USB Mass Storage v1.0. (USB devices that operate as a removable disc in Windows (2000 or later) without additional driver installation.)
- 2. MP3 Player: HDD and flash type MP3 players.
- 3. Digital camera: Cameras that support USB Mass Storage v1.0.
- . Cameras that operate as a removable disc in Windows (2000 or later) without additional driver installation.
- 4. USB HDD and USB Flash Drive: Devices that support USB2.0 or USB1.1.
 - You may experience a difference in playback quality when you connect a USB1.1 device. • For a USB HDD, make sure to connect an auxiliary power cord to the USB HDD for proper operation.
- 5. USB card Reader: One slot USB card reader and Multi slot USB card reader.
 - Depending on the manufacturer. the USB card reader may not be supported. If you install multiple memory devices into a multi card reader, you may experience problems
- 6. If you use a USB extension cable, the USB device might not be recognized.

Supported Formats

	File name	File extension	Bit rate	Version	Pixel	Sampling Frequency
Still Picture	JPG	JPG .JPEG	-	-	640x480	-
Music	MP3	.MP3	80~384kbps	-	-	44.1kHz
	WMA	.WMA	56~128kbps	V8	-	44.1kHz
	VCD	MPG.MPEG .DAT	1.5Mbps	VCD1.1,VCD2.0	320x480	44.1KHz
Movie	WMV	.WMV	4Mbps	V1,V2,V3,V7	720x480	44.1KHz~48KHz
	DivX	.AVI,.ASF	4Mbps	DivX3.11~DivX5.1,Xvid	720x480	44.1KHz~48KHz

- CBI (Control/Bulk/Interrupt) is not supported.
- Digital Cameras that use PTP protocol or require additional program installation when connected to a PC are not supported.
- A device using NTFS file system is not supported. (Only FAT 16/32 (File Allocation Table 16/32) file system is supported.)
- · Some MP3 players, when connected to this product, may not operate depending on the sector size of their file system.
- The USB HOST function is not supported if a product that transfers media files by its manufacturerspecific program is connected.
- Does not operate with Janus enabled MTP (Media Transfer Protocol) devices.
- The USB host function of this product does not support all USB devices. For information on the supported devices, see page 66.

3-4 Samsung Electronics

4. Adjustments

DVD flash Initialization & Update

. Checking out MICOM & MPEG flash Version

- 1) Play DVD-DISC or CD-DISC,
- 2) Press 'MENU' button on the Remote Control,
- 3) Press '8', '9', '5' one by one, then press 'ENTER'

. DVD flash Initialization & Update (firmware)

- 1) Prepare DISC-CD ,DVD or the USB device that contains HEX file for Update.
- 2) Play the DISC or connect the USB cable, then 'Updating' will appear on the screen, then Power will go on and out.
- 3) Then DISC-TRAY will OPEN, then remove DISC or take off USB cable, making Unit 'NO DISC' state'.
- 4) Press 'STOP' button of Main Unit 5 seconds more, Display Indicator shows 'INITIALIZE' then Power go out.
- 5) Initialization complete.



Connecting USB



TV Display(On Updating)



Update start

Samsung Electronics 4-1

5. How to disassemble

- * CAUTIONS
 - 1. To avoid damage to the product, follow the disassembly method in the Service Manual.
 - 2. As some Semiconductor devices are very sensitive to static, ensure that all procedures are adhered to when handling ESD's.

Disassembling	Picture
1. Remove 2 screws on each side and 2 screws in the rear. and remove the cabinet-top.	
2. Remove 2 screws on the left,right side. Lift and pull out the cabinet front.	
3. Remove the wire connected to the cabinet front.	
4. Remove the bracket amp. by unfastening 3 screws.	

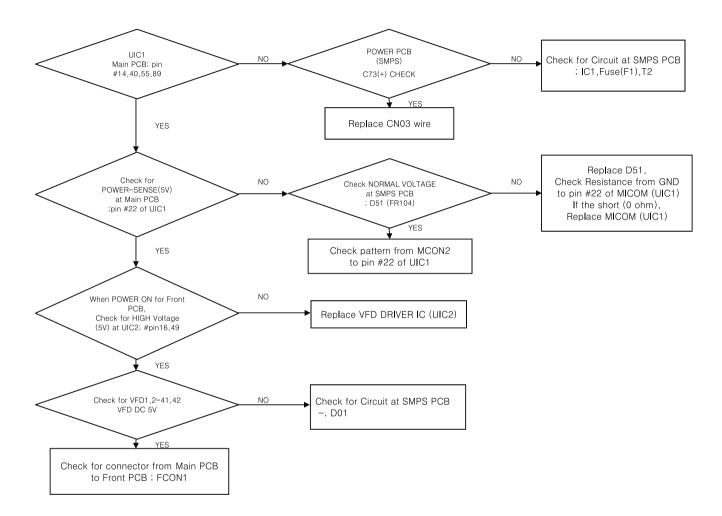
5-1 Samsung Electronics

5	
Disassembling	Picture
5. Remove the wires between PCBs.	
6. Remove the screws on the PCBs.	
7. Remove the remaining screws in the rear.	
8. Remove the MECHA and then the wire.	
9. Disassembly is complete.	

Samsung Electronics 5-2

6. TroubleShooting

1. Main



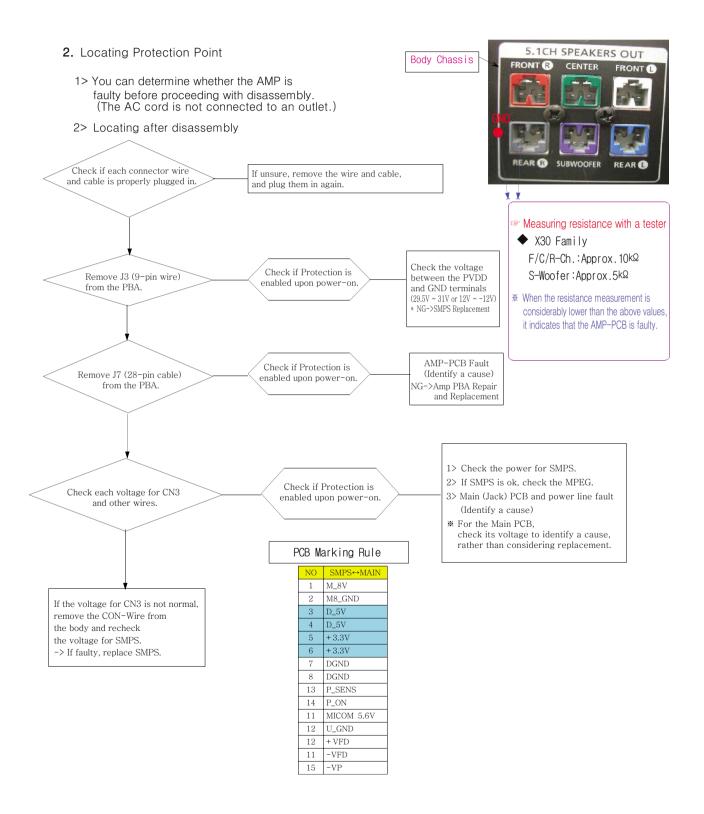
6-1 Samsung Electronics

Actions to take when Protection is enabled

■ Locating a PBA that causes Protection.

- 1. Protection Conditions
 - 1> The PVDD voltage (CN02) for SMPS is higher or lower than normal. Normal: PVDD (CN02): 28 V ~ 31 V
 - 2> The Power Stage is over-current (Over-output and SPK Short).
 - 3> The temperature of the Power Stage is more than or equal to 150℃ (Thermal Protection).
 - 4> The 2nd voltage is short and open.

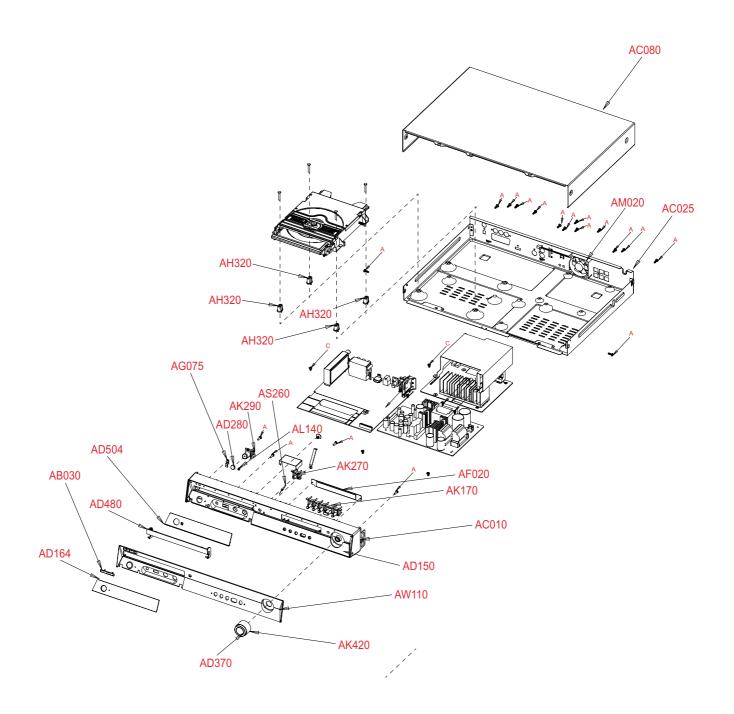
Samsung Electronics 6-2



6-3 Samsung Electronics

7.Exploded Views and Parts List

1. Total Exploded View



Samsung Electronics 7-1

2. Parts List

Location	CODE NO.	NAME	SPEC	Q'ty [EA]
				_
	AH97-01831A	ASSY DVD DECK-SDM-D1FL	BASIC-TYPE,CMS-S75RBL,SDM-D1FL	1
AH320	AH61-02320A	HOLDER-MECHA	HT-X30,ABS 94HB,-,-,-,BLK,-	4
	AH64-02320B	DOOR-TRAY	MM-KT8,ABS,-,-,-,-	1
AC025	AH64-03790H	CABINET-BOTTOM REAR	HT-X30/KOR,SECC,T0.6,W430,-,-,-,EUR	1
AC080	AH64-03791C	CABINET-TOP	HT-Q20,PCM,0.5T,-,-,-,-	1
AS260	AH61-02122B	SPRING ETC-DOOR	-,SUS304,-,-,-,-,Q9,-,-	1
AG075	AH61-02321A	GUIDE-DOOR	HT-X30,ABS 94HB,-,-,-,BLK,-	1
AF020	AH63-01327A	FILTER-VFD	HT-X30,PMMA 94HB,-,-,-,VIOLET,-	1
AB030	AH64-03746A	BADGE-SAMSUNG-35	ALL,AL,-,-,-,-,SAMSUNG	1
AC010	AH64-04192B	CABINET-FRONT	HT-X30,HIPS,T2.5,-,-,-,-	1
AW110	AH64-04193F	WINDOW-FRONT	HT-TX35/EUR,PMMA,-,-,-,-,-	1
AD164	AH64-04194C	DECORATION-HIDDEN	HT-X30/EUR,ABS,T2.0,-,-,-,-	1
AD150	AH64-04195C	DECORATION-FRONT	HT-X30/EXP,ABS,T2.0,-,-,-,-	1
AD280	AH64-04196B	DECORATION-POWER	HT-X30,ABS,-,-,-,-,CR PLANTING	1
AD480	AH64-04198B	DOOR-CD	HT-X30,PMMA SMOKE,T2.0,-,-,-,-	1
AD504	AH64-04199B	DOOR-HIDDEN	HT-X30,ABS,T2.0,-,-,-,BLACK SPRAY	1
AK290	AH64-04200A	KNOB-POWER	HT-X30,ABS 94HB,-,-,-,-,MILKY,-,-	1
AK270	AH64-04201A	KNOB-OPEN	HT-X30,ABS 94HB,-,-,-,BLK,-,-	1
AK170	AH64-04202B	KNOB-FUNCTION	HT-X30,ABS,-,-,-,-,-	1
AL140	AH67-00452A	LENS-POWER	HT-X30,PMMA 94HB,MILKY,-,-,-	1
AD370	AH64-04197B	DECORATION-VOLUME	HT-X30,ABS,-,-,-,-,CR PLANTING	1
AK420	AH64-04203B	KNOB-VOLUME	HT-X30,ABS,-,-,-,-,SPRAY	1
AM020	AH31-00039B	MOTOR FAN	C151BK10A2430,RDM5015S	1
A	6003-000276	SCREW-TAPTITE	BH,+,-,B,M3,L10,ZPC(WHT),SWRCH18A,-	18
В	6003-000279	SCREW-TAPTITE	BH,+,-,B,M3,L20,ZPC(WHT),SWRCH18A,-	4
С	6003-001561	SCREW-TAPTITE	BH,+,-,B,M3,L6,ZPC(WHT),SWRCH18A,RF	8
-			, , , , , , , , , , , , , , , , , , ,	-

7-2 Samsung Electronics

8. Electrical Parts List

FCON2 3711-002807 HEADER-BOARD TO CABLE;BOX,6P,1R,2mm,STRA MC33 2401-002042 C-AL;220uF,20%,10V,GP,TP,6.3x11,5 C-CER,CHIP;0.022nF,5%,50V,C0G,1608 FCW3 AH39-00938A CONNECT WIRE;HT-X30,2547,UL,7P,630mm,RED MC34 2203-005148 C-CER,CHIP;0.022nF,5%,50V,C0G,1608 C-CER,CHIP;100nF,10%,16V,X7R,1608	Location	n no. Code n	o. Description & Specification Remarks	Location	no. Code r	no. Description & Specification Remarks
CAL 1001-00016						
AC18 2401-000400 CAL-10uF20W-SV0CPTP5+115 MS ARZ 2213-000531 CCERC CHIP 2-76 FWS.SV0CPTP5-5115 MS ARZ 2213-000531 CCERC CHIP 2-76 FWS.SV0CPTP5-515 MS ARZ 2213-000531 CCERC CHIP 2-76 FWS.SV0CPTP5-515 MS ARZ 2213-000531 CCERC CHIP 2-76 FWS.SV0CPTP5-517 MS ARX 2213-000531 CCERC CHIP 2-76 FWS.SV0CPTP5-517 MS ARX 2213-000531 CCERC CHIP 2-76 FWS.SV0CPTP5-517 MS ARX 2213-000531 CCERC CHIP 2-76 FWS.SV0CPTP5-517 MS CCERC CHIP 2-76 FWS.SV0CPTP5-517		****	HT-Y30 Parts List	FR7	2007-000134	R-CHIP;33Kohm,5%,1/10W,TP,1608
ACIS 204-004095 C-4/CINCIP 205-00/CINC PTPS 15 S ACIS 204-004095 C-4/CINC 204-00495 C-4/C		****	III AUV I AILO LIOL		0403-001064	DIODE-ZENER;RLZ5.1B,4.94-5.2V,500mW,LL-3
AC21. 2264-00831 CCERC (PIPE 276-10%-59/XZF, 1608 HZZ 2040-0085) CCERC (PIPE 2016-75-58). AC3. 2264-00851 CCERC (PIPE 2016-75-58). AC6. 2264-00851 CCERC (PIPE 2016-75-58). AC7. 2264-00851 CCERC (AC10	2404 000400	C AL :10::E 200/ F0V/CDTD 5:/14 5			
ACS1 203-000151 CCERC HIP-10.0333n F.57.8.9.07.006 1908 HC20 2249-000505 CCERC HIP-10.006 // 40.0-207.107/991608 HC20 2249-000025 CAL. 10.006 // 40.0-207.107/991608 HC20 2249-00070 CAL. 10.006 // 40.0-207.107/991608 HC20 207-000073 RCERC HIP-10.006 // 40.0-207.107/991608 HC20 207-000073 RCERC HIP-10.006 // 40.0-207.006 HC20 207-000073 RCH HIP-10.006 // 40.0-207.006 // 40.0-207.006 HC20 207-000073 RCH HIP-10.006 // 40.0-207.0				_		
AGE 1002-00132						
AJT 372-001580 J. CAPFROMETPS, SPIA AB BLK- ART 972-001580 P. CABAPT STORY OF THE						
AMP-PI						
ABT 2007-000190 R-CHEP-3806-m35,1/10WTP1608 HLU 2007-000737 R-CHEP-3806-m35,1/10WTP1608 HRU 2007-000737 R-CHEP-3806-m35,1/10WTP1608 HRU 2007-000737 R-CHEP-3806-m35,1/10WTP1608 HR2 2007-00073 R-CHEP-3806-m35,1/10WTP1608 HR2 2007-00073 R-CHEP-3806-m35,1/10WTP1608 R-R2 2007-00074 R-CHEP-3806-m35,1/10WTP1608 R-R2 2007-00074 R-R2 2007-00						
BGS 2020-001607 CCER CHIPP (22E) F38, SOV (MPG), 1680 HOLDE AH61-02117A HOLDE R-16217A HOLDE R-16						
BRKE AM5142123A BRACKET-READY-HT-202 SPTE 0.5Tr						
C1C2R2 223-09073						
C12RR 2020-001534 CCER, CHIP 330F, 159, 50, VXTR, 1608 RR32 2007-000073 R-CHIP; 1300-00153, 170W, 171 1608 C16SW 2020-00257 CCER, CHIP; 1006, 196, 50, VXTR, 1608 RR31 2007-000073 R-CHIP; 1300-00153, 170W, 171 1608 C16SW 2020-00257 CCER, CHIP; 1006, 196, 50, VXTR, 1608 RR51 2007-000643 R-CHIP; 1000-0016, 196, 50, VXTR, 1608 RR51 2007-000643 R-CHIP; 1000-0016, 196, 196, 196, 196, 196, 196, 196, 1						
C1SSW 2209-000239		2203-001634				
CIGRU 2009-000273 CCER.CHIP-1006-189-079-2517-1500 HRS1 2007-000643 R-CHIP-2700bm,7%,110W17-1608 CC2F RS2 2007-00067 CER.CHIP-03.NNF-35.90/C03.FT.P2012 HRS5 2007-00067 R-CHIP-1700bm,7%,110W17-1608 CC2F RS2 2007-00067 CER.CHIP-03.NNF-35.90/C03.FT.P2012 HRS5 2007-00067 R-CHIP-1700bm,7%,110W17-1608 CC2F RS2 2007-00067 CER.CHIP-03.NNF-35.90/C03.FT.P2012 HRS5 2007-00067 R-CHIP-1700bm,7%,110W17-1608 CC2F RS2 2007-00067 CER.CHIP-1700bm,7%,110W17-1608 CC2F RS2 2007-00067 FERSILCORD FCS6 PS1-12S MM, STA 2007-000		2203-005249				
C19FL 2203-002733 C-2CER.CHIP;1000F;196029%,25V(9F)Re3.xH1;5 HR53 2007-000143 R-CHIP;1206m;5%,170W,TP;1608 2024 2024 2024 2025 C-2CER.CHIP;203w;5%,50V(CR) T2;9012 HR55 2007-000167 R-CHIP;1206m;5%,170W,TP;1608 2024 2024 2025 C-2CER.CHIP;205w;5%,50V(CR) T2;9012 HR55 2007-000187 R-CHIP;1206m;5%,170W,TP;1608 2024 2024 2025 C-2CER.CHIP;205w;5%,50V(CR) T2;9012 HR55 2007-000187 R-CHIP;1206m;5%,170W,TP;1608 2024 2024 2024 2024 C-2CER.CHIP;205w;5%,50V(CR) T2;9012 HR55 2007-000187 R-CHIP;1206m;5%,170W,TP;1608 2024 2024 2024 C-2CER.CHIP;205w;50V(CR) T2;00V(CR) T2;00	C16RL	2203-000257				
2 2401-000303		2203-002793				
CZEPK CZEP		2401-000303				
C2AFL 2401-002000 C-AL_761P_20Y_50V_GRTP6.3x11,5mm		2203-000787				
C278R 2305-000407 C-FLIMLEAD-PEF-770R-5%; 100V.PF;-5mm		2401-002300	C-AL;47•ÏF,20%,50V,GP,TP,6.3x11,5mm			
CECC6 2401-000420 CAL.1600F,20%,10KP,TF,5511.5		2305-000407				
CECAL 3004-000024						
CECK1 2007-000073 CONNECTOR-PEPC/EPC/EPC/EPC/EPC/EPC/EPC/EPC/EPC/EPC						
CECK1 2802-00179 RESONATOR-CERAMIC, AMPLZ, 0.5%, BK, 8X3X5, SMM C14 8091-002518 C-MDOS LOGIC, 74LCX157, 2-INPUT MULTIPLEX C15C						
CEIC3 103-00133 C-EERROM_2-4C08A_1Ks2Bit_SOP_8F_5x4mm_, C3 090-400288 C-USC_IBIB022_2Bit_CPF_88P_9x9mm_,48M C-POSI_FIXED REG.;API117_SOT-223_P;138 C3 1205-003165 C-USC_IBIT_PR_8PP_18P_18P_18M_,4117_200_P;178_P\$ C-USC_IBIT_PR_8PP_18P_28P_18M_,4117_200_P;178_P\$ C-USC_IBIT_PR_8PP_18P_28P_18M_,4117_200_P;178_P\$ C-USC_IBIT_PR_8PP_18P_28P_28M_,4117_200_P;178_P\$ C-USC_IBIT_PR_8PP_18P_28P_28M_,4117_200_P;178_P\$ C-USC_IBIT_PR_8PP_18P_28P_28M_,4117_200_P;178_P\$ C-USC_IBIT_PR_8PP_18P_28P_28M_,4117_200_P;178_P\$ C-USC_IBIT_PR_8PP_18P_28P_28M_,4117_200_P;178_P\$ C-USC_IBIT_PR_8PP_28P_28P_28M_,4117_200_P;178_P\$ C-USC_IBIT_PR_8PP_28P_28P_28M_,4117_200_P;178_P\$ C-USC_IBIT_PR_8PP_28P_28P_28P_28P_28P_28P_28P_28P_28P				IC14		
CEIC3 1203-002425 C-POSLFIXED REG.;AP1417,SO7-223,8P,138 C31 1205-003165 C-TRANSMITTER,ES7/120T,TOP.p08P,12x12mm,				IC1CW	1201-002236	IC-AUDIO AMP;TAS5152,PSOP3,36P,15.9x11mm
CER10 0505-001679 FETSILICON;FDC6301N,N,25V,0.22A,5OHM,0. CI				IC3	0904-002088	IC-USC;UBI9022,8Bit,QFP,48P,9x9mm,48M
CER10 2007-000081 R-CHIP;27Kohm,5%,1/10W,TP;1608 C5 1107-001595 C-FLASH MEMORY;49BV162AT,16Mbit;1MM;16/2				IC31	1205-003165	IC-TRANSMITTER;ES7120T,TQFP,80P,12x12mm,
CER10 2007-000093 R-CHIP;20Kohm,5%,1/10W,TP;1608 J3 AH39-00854A WIRE HARNESS;HT-Q20,-1007,9P;130mm,-AW CER10 2007-000072 R-CHIP;12kohm,5%,1/10W,TP;1608 JK7 3701-001314 CONNECTOR-HDMI;19P,2R,FEMALE,SMD-A,AU CER3 2007-000084 R-CHIP;12kohm,5%,1/10W,TP;1608 L1SW 2700-00130 INDUCTOR-RADIAL;10UH,10%,19x15.8mm CM2 3711-005155 HEADER-BOARD TO CABLE;BOX,5P;1R,2MM,SMD-STIN,N L4RR AH27-00055A COIL CHOKE;DBF-1310A,HT-DS600,10UH;-;-2 CN2 3711-005155 HEADER-BOARD TO CABLE;BOX,5P;1R,2MM,SMD-SSN LED1 0601-001432 LED;ROUND,BLUE,Jamm,455nm CN3 3708-001765 CONNECTOR-FPC/FP(PIC;24P,0.5mm,SMD-S,SN LED2 0601-001432 LED;ROUND,BLUE,Jamm,455nm CN3 3711-00471 HEADER-BOARD TO CABLE;3WALL,4P;1R,2mm,ST MAIN AH41-01029A PCB MAIN;HTX30,penol_2,1,15T;197*197 EBD13 3301-0010691 BEAD-SMD;120bm,1,15x0,8x0.8mm,200mA,TP, MC1 2401-000243 C-CER,CHIP;3.0bm,5%,11W,TP;1608 FC1 2203-000979 C-CER,CHIP;3.0bm,5%,11W,TP,47,5 MC20 2203-000064 C-CER,CHIP;0.027,5%,50V,OF,TP,608					1105-001573	IC-DRAM;K4S281632,-,128Mbit,8Mx16Bit,T
CER10 2007-000122 2007-00022 R-CHIP;12Kohm,5%,1/10W,TP;1608 J/T 3701-000314 3701-000334 CONNECTOR-HDMI;19P.2R,FEMALE,SMD-A,AU CER3 2007-000084 2007-000084 R-CHIP;2/EMM,5%,1/10W,TP;1608 JP6 437-00055A AH37-0005A 2702-001130 MOIDUTOR-RADIAL;10uH;10W,19x15.8mm CN1 3708-00203 371-002155 CONNECTOR-PFC/PFC/PIC;6P;1MM,SMD-S,TIN,N L4RR AH27-00055A COIL CHOKE,DBF-1310A,HT-D5600,10uH,-,2 EDR,31mm,897mm,3.85.2m COIL CHOKE,DBF-1310A,HT-D5600,10uH,-,2 EDR,31mm,897mm,3.85.2m CN3 3708-001765 CONNECTOR-PFC/PFC/PIC;24P,0.5mm,SMD-S,SN LED2 0601-001238 LEDR,ROWDR,PED,3.1mm,897mm,3.85.2m CN5 3711-000471 BEADER-BOARD TO CABLE;3WALL,4R]1R,2mm,ST MAIN AH41-01029A PCB,ROUND,BLUE,3mm,455.mm EBN3 301-001069 BEAD-SMD;120ohm,1.6x0.8x0.8mm,200mA,TP, BED3 MC12 2007-000092 CAL;1000F20%,10V,GP;TP6.3x5,5 EMR3 2007-000999 C-CER,CHIP;3.0MIVS-6003-E08,50V,- FC12 MC12 2007-000092 CAL;1000F20%,10V,GP;TP6.3x5,5 FC0 2401-000175 C-AL;47UF,20%,16V,GP,TF5,11mm,5mm MC21 2203-000686 C-CER,CHIP;0.02660F,0V,TXF,1608 FC0N2 A193-000380 C-AL;2.2UF,20%,50V						
CER3 2007-000071 R-CHIP;22ohm,5%,1/10W,TP;1608 JP6 AH37-00005A JACK-RCA;1P;S-440B, YELLOW,-SHIELD PLAT CER9 2007-000084 R-CHIP;22ohm,5%,1/10W,TP;1608 L1SW 2702-001130 INDUCTOR-RADIAL;10uH,10%,19x;15,8mm CN1 3708-001765 CONNECTOR-FPC/FFC/PIC;6P;1MM,SMD-S,INN L4RR AH27-00055A COIL CHOKE;DBF-1310A,HTD:5800,10uH,-r,-2 CN3 3708-001765 CONNECTOR-FPC/FFC/PIC;24P,0.5mm,SMD-S,SN LED1 0601-001432 LED;ROUND,RED,3.1mm,697nm,3.8x5.2m CN5 3711-00471 HEADER-BOARD TO CABLE;3WALL,4P1R,2mm,ST MAIN AH41-01029A PCB MAIN;HTX30,penol,2,-1.6T,197*197, EBR03 2007-000684 R-CHIP;3.30hm,5%,1/8W,TP.2012 MC12 2007-000092 C-ALL;100uF,20%,10V,GPT;P6.3X5,5 ECR 2401-000231 C-CER,CHIP;0.30hm,5%,1/8W,TP.2012 MC20 2203-000646 C-CER,CHIP;0.024NF,5%,50V,COG,TP1608 FC1 2203-000979 C-CER,CHIP;47nF,10%,50V,XTR,TF,2012 MC20 2203-000646 C-CER,CHIP;0.024NF,5%,50V,COG,1608 FC6 2401-00051 C-AL;24UF,20%,50V,GP,TP,4x7,5 MC23 2203-000640 C-CER,CHIP;0.027nF,5%,50V,COG,1608						
CERP 2007-000084 R-CHIP;4.7Kohm,5%,1/10W,TP,1608 LISW 2702-001130 InDUCTOR.RADIAL;10uH,10%,19x15,8mm CM1 3708-000223 CONNECTOR.FPC/FFC/IPC;68;1MM,SMD-S,TIN,						
CN1 3708-002023 CONNECTOR-FPC/FFC/PIC;6F;1MM,SMD-S,TIN,N LARR APZ-00055A COIL CHOKE;DBF-1310A,HT-DS600,10uH,,2 COIL CHOKE;DBF-1310A,HT-DS600,110H,,2 COIL CHOKE;DBF-1310A,HT-DS600,10uH,,2 COIL CHOKE;DBF-1310A,HT-DS600,10uH,,2 COIL CHOKE;DBF-1310A,HT-DS600,10uH,,2 COIL CHOKE;DBF-1310A,HT-DS600,10uH,,2 COIL CHOKE;DBF-1310A,HT-DS600,110H,,2 COIL CHOKE;DBF-1310A,HT-DS600,110H,,2 COIL CHOKE;DBF-1310A,HT-DS600,110H,,2 COIL CHOKE;DBF-1310A,HT-DS600,H						
CN2 3711-005155 HEADER-BOARD TO CABLE;BOX,5P,1R,2MM,SMD- CN3 3708-001765 CONNECTOR-FPC/FFC/PIC;24P,0.5mm,SMD-S,SN CN5 3711-000471 HEADER-BOARD TO CABLE;3WALL,4P,1R,2mm,ST CN5 3711-000471 HEADER-BOARD TO CABLE;3WALL,4P,1R,2mm,ST EBD13 3301-001069 BEAD-SMD;120ohm,1.6x0.8x0.8mm,200mA,TP, EMR3 2007-000694 R-CHIP;3.3ohm,5%,1/8W,TP,2012 MC12 2007-000092 R-CHIP;3.3ohm,5%,1/8W,TP,2012 MC12 2007-000094 R-CHIP;3.ohm,5%,1/6W,TP,2012 MC12 2007-000094 R-CHIP;0.04NF,5%,50V,C0G,TP;1608 ESD3 0406-001128 DIODE-TVS;MLVS-0603-E08,50V, FC1 2203-000979 C-CER,CHIP;47nF,10%,50V,X7R,TP,2012 MC2 2203-000040 C-CER,CHIP;0.02ANF,5%,50V,C0G,TP;1608 FC2 2401-001975 C-AL;47uF,20%,616V,GP,TP,5x11mm,5mm MC21 2203-001083 C-CER,CHIP;0.050nF,0.1pF,50V,NP0,1608 FC3 2401-000651 C-AL;2.2uF,20%,50V,GP,TP,4x7,5 MC23 2203-000681 C-CER,CHIP;0.025nF,5%,50V,C0G,1608 FCON2 3711-002807 HEADER-BOARD TO CABLE;BOX,6P,1R,2mm,STRA MC3 2401-002042 C-AL;2.2uF,20%,50V,C0G,1608 FCW3 A139-00338A CONNECTOR-FPC/FFC/PIC;22P,1.25MM,STRAIGH MC3 2203-000664 C-CER,CHIP;0.025nF,5%,50V,C0G,1608 FCW3 A139-00338A CONNECT WIRE;HT-X30,5P,2mm,200mm,UL,6P,2 MC3 2203-000664 C-CER,CHIP;0.025nF,5%,50V,C0G,1608 FCW3 A139-00338A CONNECT WIRE;HT-X30,2547,UL,7P,630mm,RED MC48 2203-005148 C-CER,CHIP;0.025nF,5%,50V,C0G,1608 FCW3 A139-00384 CONNECT WIRE;HT-X30,2547,UL,7P,630mm,RED MC48 2203-005148 C-CER,CHIP;0.025nF,5%,50V,C0G,1608 FCW3 A139-00384 CONNECT WIRE;HT-X30,2547,VL,7P,630mm,RED MC68 2001-000402 TR-SMALL SIGNAL;KTA1273,PNP,30V,30V-2 MC68 2401-000407 C-AL;10UF,20%,10V,GP,TP,3.5X5,2.5 FG3 0501-000422 TR-SMALL SIGNAL;KTA1273,PNP,30V,30V-2 MC68 2401-000407 C-AL;MD,330UF,20%,6.3V,GP,TP,6.6X6.6X7 FCW4 0504-000128 TR-SMALL SIGNAL;KTA1273,PNP,30V,30V-2 MC68 2401-000407 C-AL;MD,330UF,20%,6.3V,GP,TP,6.6X6.6X7 FCR1 2001-000022 R-CARBON(S);330HM,5%,1/2W,AA,TP,2.4X6.4M MCON1 3711-00410 HEADER-BOARD TO CABLE;BOX,3P,1R,2mm,STRAIGHT, FR162 2007-0000123 R-CHIP;1250hm,5%,1/10W,TP,1608 MCON2 3710-001425 WCREA 2007-000024 R-CHIP;1250hm,5%,1/10W,TP,1608 MCON2 3709-001287 WCN2 2007-000042 R-CHIP;1250hm						
CN3 3708-001765 CONNECTOR-FPC/FFC/PIC;24P,0.5mm,SMD-S,SN						
CN5 3711-000471 HEADER-BOARD TO CABLE;3WALL,4P,1R,2mm,ST BED13 3301-001069 BEAD-SMD;1200hm,1.6x0.8x0.8mm,200mA,TP, MC1 2401-000243 C-AL;100uF,20%,10V,GP,TP,6.3x5,5 EMR3 2007-000694 R-C-HIP;3.30hm,5%,1/8W,TP,2012 MC12 2007-000092 R-C-HIP;15K0hm,5%,1/10W,TP,1608 C-C-ER,CHIP;0.020hm,5%,50V,COG,TP,1608 C-C-ER,CHIP;0.020hm,5%,1/10W,TP,1608 C-C-ER,CHIP;0.020hm,5%,5%,50V,COG,TP,1608 C-C-ER,CHIP;0.020hm,5%,5%,50V,COG,TP,1608 C-C-ER,CHIP;0.020hm,5%,5%,50V,COG,TP,1608 C-C-ER,CHIP;0.020hm,5%,5%,50V,COG,TP,1608 C-C-ER,CHIP;0.020hm,5%,5%,50V,COG,TP,1608 C-C-ER,CHIP;0.020hm,5%,5%,50V,COG,TP,1608 C-C-ER,CHIP;0.020hm,5%,5%,50V,COG,TP,1608 C-C-ER,CHIP;0.020hm,5%,5%,50V,COG,TP,1608 C-C-ER,CHIP;0.020hm,5%,5%,50V,COG,TP,1608 C-C-ER,CHIP;0.020hm,5%,5%,50V,COG,1608 C-C-ER,CHIP;0.027hr,5%,50V,COG,1608 C-C-ER,CHIP;0.027hr,5%,50V,COG,1608 C-C-ER,CHIP;0.027hr,5%,50V,COG,1608 C-C-ER,CHIP;0.027hr,5%,50V,COG,1608 C-C-ER,CHIP;0.022hr,5%,50V,COG,1608 C-C-ER,CHIP;0.022hr,5%,10V,GP,TP,6.3X6.6X7 C-C-ER,CHIP;0.022hr,5%,10V,GP,TP,6.3X6.6X7 C-C-ER,CHIP;0.005hr,0.25pr,50V,FV,1608 C-C-ER,CHIP;0.005hr,0.25pr,50V,FV,1608 C-C-ER,CHIP;0.005hr,0.25pr,50V,FV,1608 C-C-ER,CHIP;0.005hr,0.25pr,50V,FV,1608 C-C-ER,CHIP;0.005hr,0.25pr,50V,FV,1608 C-C-ER,CHIP;0.005hr,0.25pr,50V,FV,1608 C-C-ER,CHIP;0.005hr,0.25pr,50V,FV,16						
EBD13 3301-00169 BEAD-SMD;120ohm;1.6x0.8x0.8mm;200mA,TP, MC1 2401-000243 C-AL;100uF,20%,10V,GP,TP;6.3x5,5 R-CHIP;13.3ohm;5%,1/8W,TP;2012 MC12 2007-000092 R-CHIP;15Kohm;5%,1/10W,TP;1608 DIODE-TVS;MLVS-0603-E08,50V,, MC19 2203-000646 C-CER,CHIP;0.024NF,5%,50V,C0G,TP;1608 C-CER,CHIP;0.044NF,5%,50V,C0G,TP;1608 C-CER,CHIP;0.045NF,5%,50V,C0G,TP;1608 C-CER,CHIP;0.050nF,0.1pF,50V,NP0,1608 C-CER,CHIP;0.050nF,0.1pF,50V,NP0,1608 C-CER,CHIP;0.050nF,0.1pF,50V,NP0,1608 C-CER,CHIP;0.050nF,0.1pF,50V,NP0,1608 C-CER,CHIP;0.050nF,0.1pF,50V,NP0,1608 C-CER,CHIP;0.050nF,0.1pF,50V,NP0,1608 C-CER,CHIP;0.050nF,5%,50V,C0G,1608 C-CER,CHIP;0.050nF,0.25pF,50V,NP0,1608 C-CER,CHIP;0.0						
EMR3 2007-000694 R-CHIP;3.30hm,5%,1/8W,TP,2012 MC12 2007-000092 R-CHIP;15.50hm,5%,1/10W,TP,1608 CFC1 2203-00079 C-CER,CHIP;47nF,10%,50V,XTR,Tmp. MC19 2203-000640 C-CER,CHIP;47nF,10%,50V,XTR,1608 C-CER,CHIP;47nF,10%,50V,XTR,Tmp. MC21 2203-000440 C-CER,CHIP;17nF,10%,50V,XTR,1608 C-CER,CHIP;47nF,10%,50V,XTR,11mm,5mm MC21 2203-001083 C-CER,CHIP;0.050nF,0.1pF,50V,NP0,1608 C-CER,CHIP;0.050nF,0.1pF,50V,NP0,1608 C-CER,CHIP;0.050nF,0.1pF,50V,NP0,1608 C-CER,CHIP;0.027nF,5%,50V,COG,1608 C-CER,CHIP;0.027nF,5%,50V,COG,1608 C-CER,CHIP;0.027nF,5%,50V,COG,1608 C-CER,CHIP;0.050nF,0.1pF,50V,NP0,1608 C-CER,CHIP;0.050nF,0.2pF,50V,NP0,1608 C-CER,CHIP;0.050nF,0.2pF,50V,NP0,1608 C-CER,CHIP;0.050nF,0.2pF,50V,NP0,1608 C-CER,CHIP;0.050nF,0.2pF,50V,NP0,1608 C-CER,CHIP;0.050nF,0.2pF,6.6X.6.6X7 C-CER,CHIP;0.050nF,0.2pF,6.6X.6.6X7 C-CER,CHIP;0.050nF,0.2pF,6.6X.6.6X7 C-CER,CHIP;0.050nF,0.2pF,6.6X.6.6X7 C-CER,CHIP;0.050nF,0.2pF,6.6X.6.6X7 C-CER,CHIP;0.050nF,0.2pF,6.0X.6PF,0.2pF,6.6X.6.6X7 C-CER,CHIP;0.050nF,0.2pF,6.0X.6PF						
ESD3 0406-001128 DIODE-TVS;MLVS-0603-E08,50V,¬; MC19 2203-000064 C-CER,CHIP;0.024NF,5%,50V,COG,TP;1608 C-CER,CHIP;47nF,10%,50V,X7R,TP;2012 MC20 2203-000044 C-CER,CHIP;0.025nF,50V,X7R,1608 C-CER,CHIP;10,050nF,0.1pF,50V,NP0,1608 C-CER,CHIP;0.0050nF,0.1pF,50V,NP0,1608 C-CER,CHIP;0.0050nF,0.2pF,50V,COG,1608 C-CER,CHIP;0.0050nF,0.2pF						
FC1 2203-000979						
FC4 2401-001975						
FCG 2401-000651 C-AL;2.2uF;20%,50V,GF,TP,4x7,5 MC23 2203-000681 C-CER,CHIP;0.027nF,5%,50V,C0G,1608 C-CER,CHIP;0.015nF,5%,50V,C0G,1608 C-CER,CHIP;0.015nF,5%,50V,C0G,1608 C-CER,CHIP;0.015nF,5%,50V,C0G,1608 C-CER,CHIP;0.015nF,5%,50V,C0G,1608 C-CER,CHIP;0.015nF,5%,50V,C0G,1608 C-CER,CHIP;0.0215nF,5%,50V,C0G,1608 C-CER,CHIP;0.022nF,5%,50V,C0G,1608 C-CER,CHIP;0.002nF,0%,16V,X7R,1608 C-CER,CHIP;0.002nF,0%,16V,X7R,1608 C-CER,CHIP;0.00417 C-CER,CHIP;0.00417 C-AL;10UF,20%,16V,GP,TP,3.5X5,2.5 TR-SMALL SIGNAL;KTA1273,PNP,30V,30V,2 MC68 2402-001198 C-AL;10UF,20%,16V,GP,TP,3.5X5,2.5 C-AL,SMD;330UF,20%,6.3V,GP,TP,6.6X6.6X7 C-CER,CHIP;0.0050nF,0.25pF,50V,NP0,1608 C-CER,CHIP		2401-001975				
FCON1 3708-000454 CONNECTOR-FPC/FFC/PIC;22P,1.25MM,STRAIGH FCON2 3711-002807 HEADER-BOARD TO CABLE;BOX,6P,1R,2mm,STRA FCW2 AH39-00936A FCW3 AH39-00938A CONNECT WIRE;HT-X30,2547,UL,7P,630mm,RED FJ1 3406-001047 SWITCH-ROTARY;5V DC,0.5mA,-,12mm FJ1 3711-000820 HEADER-BOARD TO CABLE;BOX,2P,1R,2.5MM,ST FQ3 0501-000422 TR-SMALL SIGNAL;KTA1273,PNP,-30V,-30V,-2 FQ4 0504-000128 FR1 2001-000022 FR2 FR1 2001-000022 R-CARBON(S);330HM,5%,1/2W,AA,TP,2.4X6.4M FR12 2001-000027 R-CARBON(S);22OHM,5%,1/2W,AA,TP,2.012 FR2 2007-0000123 R-CHIP;1.5Kohm,5%,1/10W,TP,1608 FR2 2007-000023 R-CHIP;1.20ohm,5%,1/8W,TP,2012 FR2 2007-000023 R-CHIP;120ohm,5%,1/8W,TP,2012 FR2 2007-000023 R-CHIP;120ohm,5%,1/10W,TP,1608 FR3 2007-000024 R-CHIP;120ohm,5%,1/10W,TP,1608 FR3 2007-000025 R-CHIP;120ohm,5%,1/10W,TP,1608 FR3 2007-000026 R-CHIP;120ohm,5%,1/10W,TP,1608 FR3 2007-000027 R-CHIP;120ohm,5%,1/10W,TP,1608 FR3 2007-000027 R-CHIP;120ohm,5%,1/10W,TP,1608 FR3 2007-000027 R-CHIP;120ohm,5%,1/10W,TP,1608 FR3 2007-000028 R-CHIP;120ohm,5%,1/10W,TP,1608 FR3 2007-000028 R-CHIP;120ohm,5%,1/10W,TP,1608 FR3 2007-000028 R-CHIP;120ohm,5%,1/10W,TP,1608 FR3 2007-000029 R-CHIP;120ohm,5%,1/10		2401-000651				
FCON2 3711-002807 HEADER-BOARD TO CABLE;BOX,6P,1R,2mm,STRA	FCON1	3708-000454	CONNECTOR-FPC/FFC/PIC;22P,1.25MM,STRAIGH			
FCW2 AH39-00936A WIRE HARNESS;HT-X30,6P,2mm,200mm,UL,6P,2 CONNECT WIRE;HT-X30,2547,UL,7P,630mm,RED SWITCH-ROTARY;5V DC,0.5mA,-;12mm MC52 2203-000062 C-CER,CHIP;100nF,10%,16V,X7R,1608 C-CER,CHIP;100nF,10%,10%,17P,1608 C-AL,SMD,100100000 C-AL,SMD,10M,10M,10M,10M,10M,10M,10M,10M,1	FCON2	3711-002807	HEADER-BOARD TO CABLE;BOX,6P,1R,2mm,STRA			
FCW3 AH39-00938A CONNECT WIRE;HT-X30,2547,UL,7P,630mm,RED 3406-001047 SWITCH-ROTARY;5V DC,0.5mA,-;12mm MC52 2203-000062 C-CER,CHIP;100nF,10%,16V,X7R,1608 C-CER,CHIP;47nF,+80-20%,50V,Y5V,1608 C-C-ER,CHIP;47nF,+80-20%,50V,Y5V,1608 C-AL;10UF,20%,16V,QF,TP,3.5X5,2.5 C-AL;10UF,20%,16V,Q	FCW2	AH39-00936A	WIRE HARNESS;HT-X30,6P,2mm,200mm,UL,6P,2			
FJ1 3406-001047 SWITCH-ROTARY;5V DC,0.5mA,-;12mm MC52 2203-000062 C-CER,CHIP;47nF,+80-20%,50V,75V,1608 FJ3 3711-000820 HEADER-BOARD TO CABLE;BOX,2P,1R,2.5MM,ST MC6 2401-000407 C-AL;10UF,20%,16V,GP,TP,3.5X5,2.5 FQ3 0501-000422 TR-SMALL SIGNAL;KTA1273,PNP,30V,-30V,-2 MC68 2402-001198 C-AL,SMD;330UF,20%,6.3V,GP,TP,6.6X6.6X7 FQ4 0504-000128 TR-DIGITAL;-,NPN,200MW,22K/22K,SOT-23,TP MC71 2203-001086 C-CER,CHIP;0.0050nF,0.25pF,50V,NP0,1608 FR1 2001-000020 R-CARBON(S);330HM,5%,1/2W,AA,TP,2.4X6.4M MCON1 3708-001086 CONNECTOR-FPC/FFC/PIC;28P,1.25MM,STRAIGH FR12 2007-000572 R-CHIP;2200hm,5%,1/8W,TP,2012 MCON1 3711-004110 HEADER-BOARD TO CABLE;3WALL,12P,1R,2MM,S FR2 2007-000023 R-CHIP;1.5Kohm,5%,1/10W,TP,1608 MCON2 AH39-00855A WIRE HARNESS;HT-Q20,-,1007,15P,110mm,-,A FR2 2007-000023 R-CHIP;120ohm,5%,1/8W,TP,2012 MCON2 3709-001287 CONNECTOR-CARD SLOT;10P,1.5mm,SMD-A,AU10	FCW3					
FJ1 3711-000820 HEADER-BOARD TO CABLE;BOX,2P,1R,2.5MM,ST FQ3 0501-000422 TR-SMALL SIGNAL;KTA1273,PNP,30V,-20V,-2 FQ4 0504-000128 TR-DIGITAL;-,NPN,200MW,22K/22K,SOT-23,TP FR1 2001-000022 R-CARBON(S);330HM,5%,1/2W,AA,TP,2.4X6.4M FR12 2001-000020 R-CARBON(S);220HM,5%,1/2W,AA,TP,2.4X6.4M FR12 2007-000572 R-CHIP;2200hm,5%,1/8W,TP,2012 FR2 2007-000023 R-CHIP;1.5Kohm,5%,1/10W,TP,1608 FR2 2007-000024 R-CHIP;1.5Kohm,5%,1/10W,TP,1608 FR2 2007-000025 R-CHIP;1.5Kohm,5%,1/10W,TP,1608 FR2 2007-000026 R-CHIP;1.5Kohm,5%,1/10W,TP,1608 FR2 2007-000027 R-CHIP;1.5Kohm,5%,1/10W,TP,1608 FR2 2007-000028 R-CHIP;1.5Kohm,5%,1/10W,TP,1608 FR2 2007-000028 R-CHIP;120ohm,5%,1/8W,TP,2012 FR2 2007-000028 R-CHIP;120ohm,5%,1/8W,TP,2012 FR2 2007-000028 R-CHIP;120ohm,5%,1/8W,TP,2012 FR3 2007-000028 R-CHIP;120ohm,5%,1/10W,TP,1608 FR2 2007-000028 R-CHIP;120ohm,5%,1/10W,TP,1608 FR3 2007-000029 R-C	FJ1					
FQ3 0501-000422 TR-SMALL SIGNAL;KTA1273,PNP,30V,-30V,-2 MC68 2402-001198 C-AL,SMD;330UF,20%,6.3V,GP,TP,6.6X6.6X7 FQ4 0504-000128 TR-DIGITAL;-,NPN,200MW,22K/22K,SOT-23,TP MC71 2203-001086 C-CER,CHIP;0.0050nF,0.25pF,50V,NP0,1608 FR1 2001-000020 R-CARBON(S);330HM,5%,1/2W,AA,TP,2.4X6.4M MCON1 3708-001086 CONNECTOR-FPC/FFC/PIC;28P,1.25MM,STRAIGH MCON1 3711-000452 CONNECTOR-HEADER;BOX,3P,1R,2mm,STRAIGHT, MCON1 3711-004110 HEADER-BOARD TO CABLE;3WALL,12P,1R,2MM,S SOCKET-BOARD TO CABLE;3WALL,12P,1R,2MM,S SOCKET-BOARD TO CABLE;12P,1R,2mm,ANGLE,S R-CHIP;22Kohm,5%,1/10W,TP,1608 MCON2 AH39-008554 WIRE HARNESS;HT-Q20,-,1007,15P,110mm,-,A CONNECTOR-CARD SLOT;10P,1.5mm,SMD-A,AU10						
FQ4 0504-000128 TR-DIGITAL;-,NPN,200MW,22K/22K,SOT-23,TP MC71 2203-001086 C-CER,CHIP;0.0050nF,0.25pF,50V,NP0,1608 CONNECTOR-FPC/FFC/PIC;28P,1.25MM,STRAIGH MCON1 3711-000452 CONNECTOR-HEADER;BOX,3P,1R,2mm,STRAIGHT, MCON1 3711-000452 CONNECTOR-HEADER;BOX,3P,1R,2mm,ANGLE,S MCON2 3710-001422 SOCKET-BOARD TO CABLE;12P,1R,2mm,ANGLE,S MCON2 AH39-00855A WIRE HARNESS;HT-Q20,-,1007,15P,110mm,-,A CONNECTOR-CARD SLOT;10P,1.5mm,SMD-A,AU10						
FR1 2001-000022 R-CARBON(S);330HM,5%,1/2W,AA,TP,2.4X6.4M MCON1 3708-001086 CONNECTOR-FPC/FFC/FIC;28P,1.25MM,STRAIGH FR12 2001-000020 R-CARBON(S);220HM,5%,1/2W,AA,TP,2.4X6.4M MCON1 3711-000452 CONNECTOR-HEADER;BOX,3P,1R,2mm,STRAIGHT, FR2 2007-000123 R-CHIP;220ohm,5%,1/10W,TP,1608 MCON2 3710-001422 SOCKET-BOARD TO CABLE;3WALL,12P,1R,2MM,S FR2 2007-000024 R-CHIP;22Kohm,5%,1/10W,TP,1608 MCON2 AH39-008554 WIRE HARNESS;HT-Q20,-,1007,15P,110mm,-,A FR2 2007-000023 R-CHIP;120ohm,5%,1/8W,TP,2012 MCON2 3709-001287 CONNECTOR-CARD SLOT;10P,1.5mm,SMD-A,AU10						
FR12 2001-000020 R-CARBON(S);220HM,5%,1/2W,AA,TP,2.4X6.4M MCON1 3711-000452 CONNECTOR-HEADER;BOX,3P,1R,2mm,STRAIGHT, FR16 2007-000123 R-CHIP;220ohm,5%,1/10W,TP,1608 MCON2 3710-001422 SOCKET-BOARD TO CABLE;3WALL,12P,1R,2MM,S FR21 2007-000094 R-CHIP;22Kohm,5%,1/10W,TP,1608 MCON2 AH39-008554 WIRE HARNESS;HT-Q20,-,1007,15P,110mm,-,A FR22 2007-000023 R-CHIP;120ohm,5%,1/8W,TP,2012 MCON2 3709-001287 CONNECTOR-CARD SLOT;10P,1.5mm,SMD-A,AU10			· ·			the state of the s
FR16 2007-000572 R-CHIP;220ohm,5%,1/8W,TP,2012 MCON1 3711-004110 HEADER-BOARD TO CABLE;3WALL,12P,1R,2MM,S FR2 2007-000123 R-CHIP;1.5Kohm,5%,1/10W,TP,1608 MCON2 3710-001422 SOCKET-BOARD TO CABLE;12P,1R,2mm,ANGLE,S FR21 2007-000024 R-CHIP;22Kohm,5%,1/10W,TP,1608 MCON2 AH39-00855A WIRE HARNESS;HT-Q20,-;1007,15P,110mm,-,A FR22 2007-000023 R-CHIP;120ohm,5%,1/8W,TP,2012 MCON2 3709-001287 CONNECTOR-CARD SLOT;10P,1.5mm,SMD-A,AU10				MCON1		
FR21 2007-000094 R-CHIP;22Kohm,5%,1/10W,TP,1608 MCON2 AH39-00855A WIRE HARNESS;HT-Q20,-,1007,15P,110mm,-,A MCON2 3709-001287 CONNECTOR-CARD SLOT;10P,1.5mm,SMD-A,AU10				MCON1	3711-004110	HEADER-BOARD TO CABLE;3WALL,12P,1R,2MM,S
FR22 2007-000023 R-CHIP;120ohm,5%,1/8W,TP,2012 MCON2 3709-001287 CONNECTOR-CARD SLOT;10P,1.5mm,SMD-A,AU10				MCON2	3710-001422	SOCKET-BOARD TO CABLE;12P,1R,2mm,ANGLE,S
MICONZ 3/03-001201 CONNECTON-CAND SECT. TOT. I.SIIIIII, SMICHA, ACTO				MCON2	AH39-00855A	WIRE HARNESS;HT-Q20,-,1007,15P,110mm,-,A
rk3				MCON2	3709-001287	CONNECTOR-CARD SLOT;10P,1.5mm,SMD-A,AU10
	rkj	2001-001165	K-CAKBUN(3);30UNW,3%,1/2W,AA,17,2.4X6.4M			

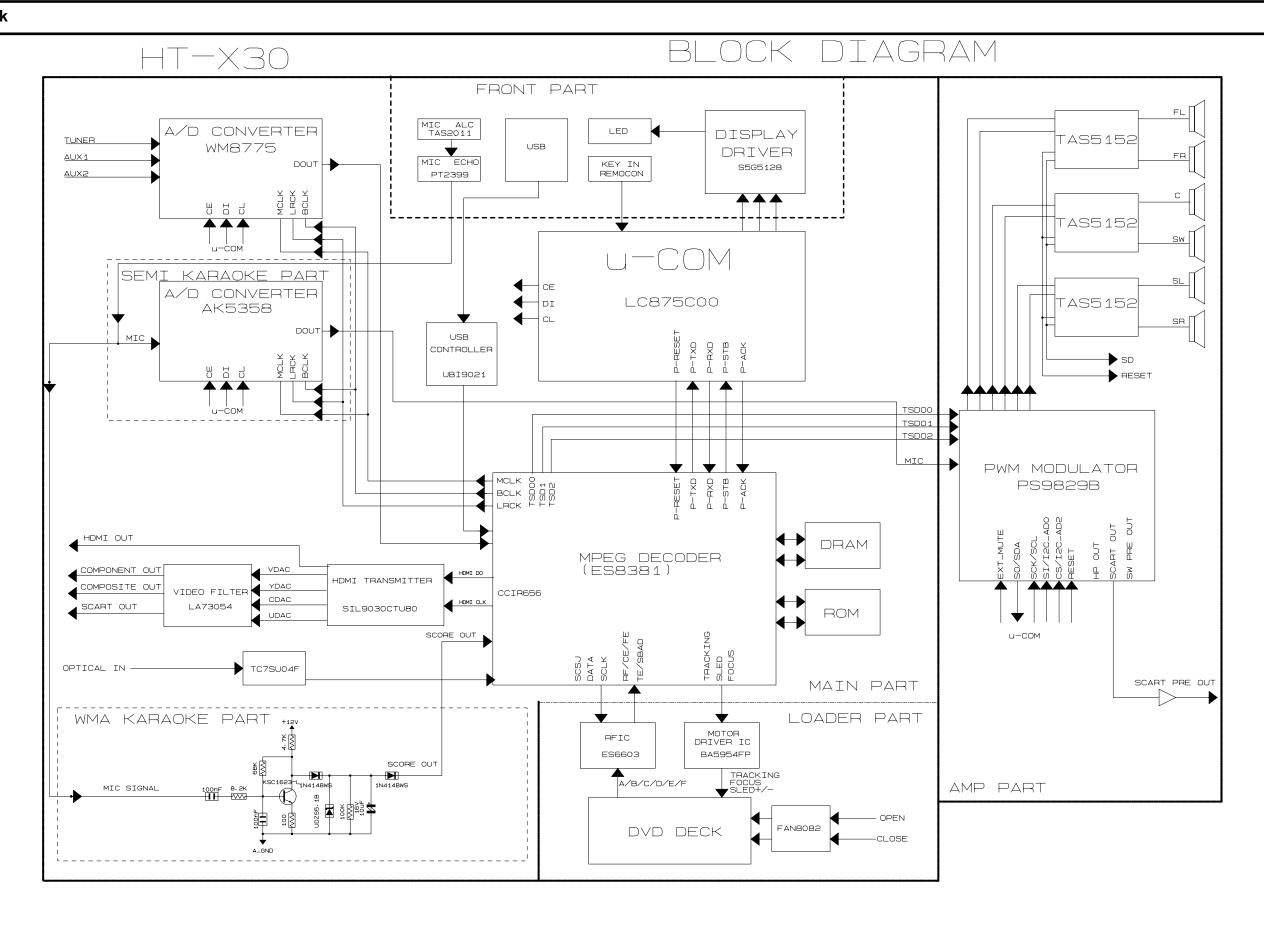
Samsung Electronics 8-1

Location	no. Code n	o. Description & Specification	Remarks	Location	no. Code n	o. Description & Specification Remarks
MCON3	3708-001033	CONNECTOR-FPC/FFC/PIC;22P,1.25MM,		RR92	2007-000102	R-CHIP;100Kohm,5%,1/10W,TP,1608
MCON6	3708-000448	CONNECTOR-FPC/FFC/PIC;6P,1.25MM,S		SC6L	2203-000998	C-CER,CHIP;0.047nF,5%,50V,C0G,1608
MCON8		TUNER;KST-MW104FV1-E50LCE,HT-Q40		SCREW	6003-000276	SCREW-TAPTITE;BH,+,-,B,M3,L10,ZPC(WHT),S
MIC1	1204-002627	IC-MODULATOR;PS9829B,LQFP,100P,14		SL1L	2703-000404	INDUCTOR-SMD;220uH,10%,3225
MIC2		IC-CMOS LOGIC;M74HCU04,-,SOP,14P,-,		SPK1	3716-001243	TERMINAL-BLOCK;-,12P,14mm,-,-
ML23	3301-001495	BEAD-SMD;120ohm,2012,2500mA,TP,11	onm/1	SW5	3404-000165	SWITCH-TACT;12V,50mA,160gf,6x6mm,SPST
ML8	2703-000185	INDUCTOR-SMD;3.3uH,10%,2012		UC1	2401-001952	C-AL;4.7uF,20%,50V,GP,TP,5x7mm,5mm
WR117	2007-000076 2007-000118	R-CHIP;330ohm,5%,1/10W,TP,1608		UC17 UC3	2203-000972	C-CER,CHIP;47nF,10%,16V,X7R,1608
MR131 MR2	2007-000118	R-CHIP;390ohm,5%,1/10W,TP,1608 R-CHIP;47ohm,5%,1/10W,TP,1608		UC57	2409-000123 2401-003221	C-EDL;47000uF,4uA,5.5V,-,BK,-,5mm C-AL;100uF,20%,16V,GP,TP,8X5,2.5
MR36	2007-000072	R-CHIP;1Mohm,5%,1/10W,TP,1608		UC58	2401-003221	C-AL;10UF,20%,50V,GP,TP,6.3X5MM,2.5
MR53	2007-000103	R-CHIP;33ohm,5%,1/10W,TP,1608		UC6	2401-000403	C-AL;220nF,20%,50V,GP,TP,5x11mm,5mm
MR71	2011-000475	R-NET;330hm,5%,1/16W,L,CHIP,8P,TP,32		UC62	2203-000236	C-CER,CHIP;0.1nF,5%,50V,C0G,1608
MR8	2007-000052	R-CHIP;10Kohm,1%,1/10W,TP,1608		UC64	2203-000975	C-CER,CHIP;47nF,10%,25V,X7R,TP,1608,-
MX1	2801-004354	CRYSTAL-UNIT;12.288MHZ,30PPM,ATS-	49/U.18	UD10	0401-001099	DIODE-SWITCHING:1N4148WS,75V,150mA,SOD-3
NC6	2401-001020	C-AL;3.3UF,20%,50V,GP,TP,4X7,5	10/0,10	UD11	0404-000156	DIODE-SCHOTTKY;RB441Q,40V,350MA,DO-34,TP
NC7	2401-000048	C-AL;47uF,20%,25V,GP,TP,5x11,5		UIC1	0903-001405	IC-MICROCONTROLLER;LC87F5CC8A,8Bit,QFP,1
NC8	2401-001164	C-AL;33uF,20%,16V,GP,TP,5x11mm,5mm	Í	UIC2	1003-001708	IC-VFD;S5G5128A,LQFP,64P,1063MIL,-,-,
NIC1	1201-000163	IC-OP AMP;4560,SOP,8P,173MIL,DUAL,1		UR15	2007-001010	R-CHIP;51Kohm,5%,1/10W,TP,1608
NQ3	0501-000010	TR-SMALL SIGNAL; KSC1008, NPN, 800m		UR2	2007-000402	R-CHIP;150ohm,5%,1/10W,TP,1608
NR15	2007-000103	R-CHIP;120Kohm,5%,1/10W,TP,1608	, ,	UR25	2007-000074	R-CHIP;100ohm,5%,1/10W,TP,1608
OPIC1	0603-001205	OPTIC TRANSMITTER;5V,13.2Mb/s,-,-,-		UR53	2007-000078	R-CHIP;1Kohm,5%,1/10W,TP,1608
PC5	2401-000118	C-AL;1000uF,20%,10V,GP,TP,10x12.5,5		USB	3722-002313	JACK-USB;4P/1C,AU30U,BLK,STRAIGHT,ATYP
PC7	2401-001364	C-AL;470uF,20%,16V,GP,TP,10x12.5,5		VC11	2401-000414	C-AL;10uF,20%,16V,GP,TP,4x7,5
PC9	2401-001102	C-AL;330uF,20%,16V,GP,TP,8x11.5mm,5		VC20	2401-000918	C-AL;22uF,20%,16V,GP,-,6.3x7,5
PCB-F	AH41-01030A	PCB-FRONT;HT-X30,penol,2,-,1.6T,197*2	47,	VC38	2401-001092	C-AL;330uF,20%,10V,GP,-,8x11.5,2.5m
PIC7	1203-002935	IC-POSI.ADJUST REG.;AIC1117ACE,TO-	252,3P	VFD	AH07-00188A	VF DISPLAY;HNV-12SN02T,HT-Q20,104.14X16.
PQ2	0501-000407	TR-SMALL SIGNAL; KSD471A-Y, NPN, 800	lmW,TO-9	VFD-H	AH61-02114A	HOLDER-VFD;HT-Q20,ABS,-,-,-,-
PQ3	0501-000002	TR-SMALL SIGNAL; KSA812, PNP, 150MW	/,SOT-23,	VIC1	1204-001978	IC-VIDEO PROCESS;LA73054,-,36P,-,SSOP,7V
PQ6	0504-000156	TR-DIGITAL;KSR2103,PNP,200MW,22K/2		VJ4	3722-002283	JACK-SCART;21P+3P,-,SN,BLK,-
PR10	2001-000027	R-CARBON;100OHM,5%,1/4W,AA,TP,2.42		VJ5	3722-002042	JACK-PIN;2P/2C,NI,WHT/RED,ANGLE
PS300				VJP2	2007-000029	R-CHIP;0ohm,5%,1/8W,TP,2012
Q5	0501-000632	TR-SMALL SIGNAL;2SB1197K,PNP,200n	nW,SOT-2	VL20	2703-000275	INDUCTOR-SMD;33UH,10%,2012
R11SW	2007-002425	R-CHIP;10hm,5%,1/10W,TP,1608		VL27	2703-002238	INDUCTOR-SMD;1UH,5%,2012
R150	2007-000941	R-CHIP;47Kohm,5%,1/8W,TP,2012		VQ10	0504-000152	TR-DIGITAL;KSR2101,PNP,200mW,4.7K/4.7K,S
R2FL	2007-000312	R-CHIP;10ohm,5%,1/4W,TP,3216		VQ11	0501-002184	TR-SMALL SIGNAL;KTD1304,NPN,200mW,SOT-23
R46	2007-000253	R-CHIP;1.5ohm,5%,1/4W,TP,3216 R-CHIP;0ohm,5%,1/10W,TP,1608		VQ7	0501-000341 2007-000082	TR-SMALL SIGNAL;KSC1623-L,NPN,200mW,SOT- R-CHIP;3.3Kohm,5%,1/10W,TP,1608
R5RL R9C	2007-000070 2007-000462			VR38 VR39	2007-000082	R-CHIP;560ohm,5%,1/10W,TP,1608
RC14	2401-000402	R-CHIP;18ohm,5%,1/8W,TP,2012 C-AL;220uF,20%,16V,GP,TP,8x9mm,5		VR62	2007-000119	R-CHIP;10ohm,5%,1/10W,TP,1608
RC17	2203-000280	C-CER,CHIP;0.01nF,0.5pF,50V,C0G,1608		VR8	2007-000309	R-CHIP;750hm,5%,1/10W,TP,1608
RC19	2203-000200	C-CER,CHIP;100nF,+80-20%,25V,Y5V,160	IQ	VR9	2007-001107	R-CHIP;3.9Kohm,5%,1/10W,TP,1608
RC28	2203-001652	C-CER,CHIP;470nF,+80-20%,16V,Y5V,160		X1	2801-004284	CRYSTAL-SMD;27MHZ,10PPM,28-AAN,20PF,30OH
RC35	2401-001355	C-AL;470uF,20%,10V,GP,TP,8x11.5mm,5		X2	2801-003863	CRYSTAL-UNIT;48MHz,30ppm,28-AAA,18pF,80o
RC40	2203-001126	C-CER,CHIP;0.68nF,10%,50V,X7R,1608		XD4	0401-001110	DIODE-SWITCHING;-,80V,100MA,SOD-523,TP
RC44	2203-002398	C-CER,CHIP;22nF,10%,50V,X7R,1608		X-TAL	2802-001174	RESONATOR-CERAMIC;10MHZ,0.5%,BK,8X3.5X3M
RC47	2203-000888	C-CER,CHIP;4.7nF,10%,50V,X7R,1608			0403-001062	DIODE-ZENER; UDZ4.7B,4.55-4.75V,200MW,SOD
RC49	2203-005015	C-CER,CHIP;150nF,+80-20%,16V,Y5V,160	18	AH61-02325		BRACKET-AMP;HT-X30,SECC,T0.5,-,-,-
RC51	2401-001938	C-AL;22uF,20%,25V,GP,TP,5x11mm,5mm		6502-00104		CABLE CLAMP;DACW130,-,T1.0,PE,BLK
RD2	0407-000116	DIODE-ARRAY;DAP202K,80V,100mA,CK		AH39-40001		CABLE-AUDIO CABLE;-,-,1P-1P,3000mm,-,-
REM_E	0609-001189	MODULE REMOCON; HORIZONTAL, 16.4		AH42-00021	IA	ANT FM T;T18011F-1,75 ohm,1800mm
RESQ1	1203-003526	IC-VOL. DETECTOR; KIA7029AP, TO-92, 31	P,4.58	AH39-00257	7F	CBF-POWER CORD;MAX980,-,CP2,250V,2.5A,18
RR16	2007-001179	R-CHIP;8.2Kohm,5%,1/10W,TP,1608		3809-00195	5	CABLE-FLAT;-,80C,180MM,22P,1.25mm,-
RR20	2007-000090	R-CHIP;10Kohm,5%,1/10W,TP,1608		AH92-02678	BA	ASSY PCB-FRONT;HT-X30EUROPE,HT-X30EUROPE
RR24	2007-000458	R-CHIP;18Kohm,5%,1/10W,TP,1608		AH44-00148	BA	SMPS;HT-X30,ORTP-616,AC/DC,800W(Aud
RR33	2007-000120	R-CHIP;680ohm,5%,1/10W,TP,1608		AH69-01875	5B	MASTER CARTON;HT-X30/EXP,PEPER,-,-,-,-
RR37	2007-000091	R-CHIP;12Kohm,5%,1/10W,TP,1608		AH92-02682		ASSY PCB-MAIN;HT-X30EUROPE,HT-X30EUROPE,
RR40	2007-000483	R-CHIP;10HM,5%,1/8W,TP,2012		AH92-02694	IA.	ASSY PCB-AMP;HT-X30EUROPE,HT-X30EUROPE,-
RR51	2007-000098	R-CHIP;56Kohm,5%,1/10W,TP,1608		AH97-02155	5A	ASSY DVD DECK-SDM D1FL;BASIC-TYPE,CMS-S7
RR52	2007-000077	R-CHIP;470ohm,5%,1/10W,TP,1608				
RR67	2007-000308	R-CHIP;10ohm,5%,1/8W,TP,2012				
RR83B	2007-000106	R-CHIP;220Kohm,5%,1/10W,TP,1608				

8-2 Samsung Electronics

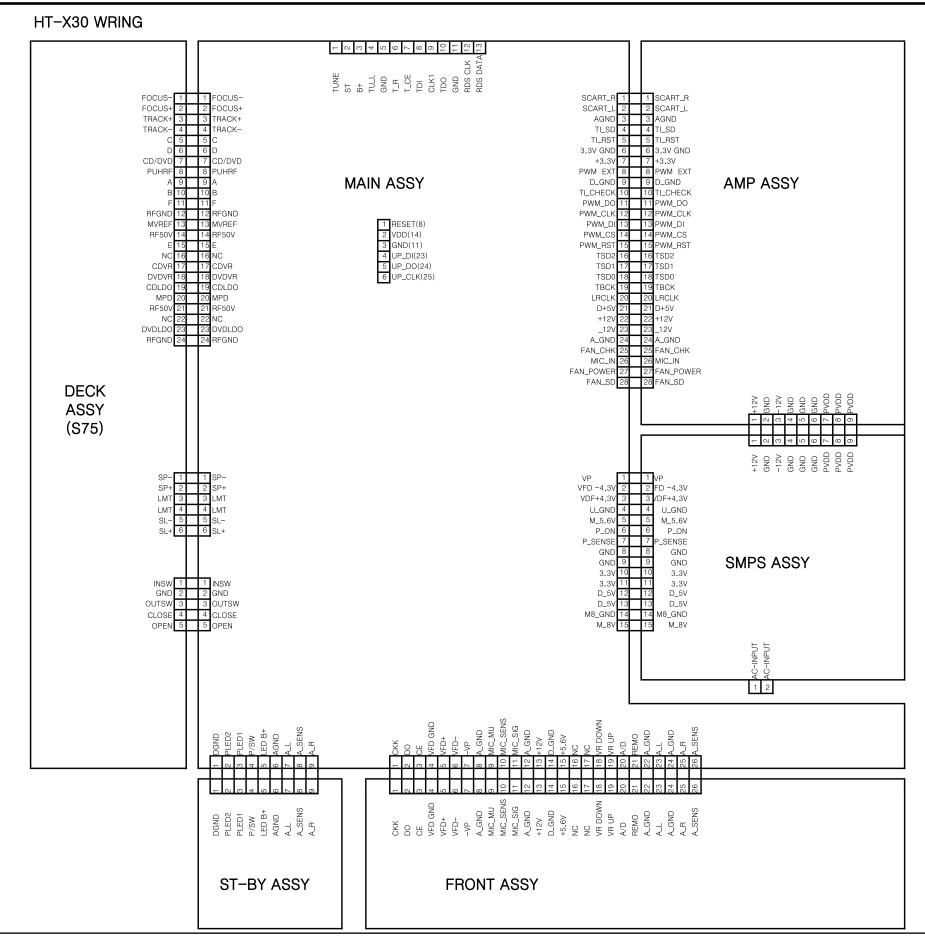
9. Block Diagram

1. Block



9-1 Samsung Electronics

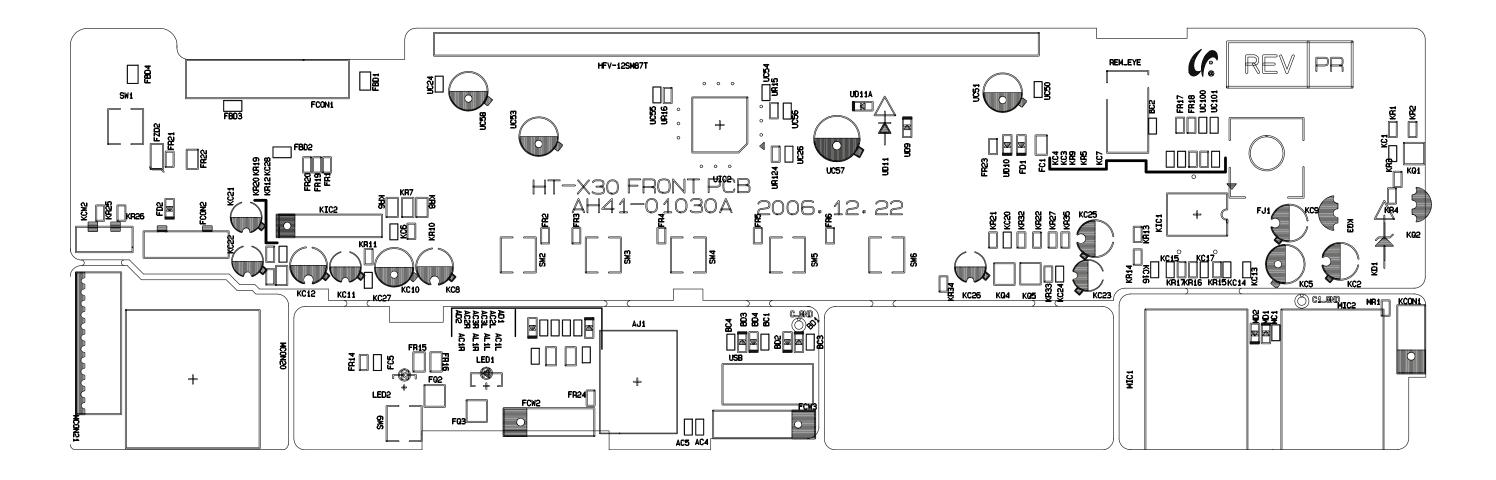
10. Wiring Diagram



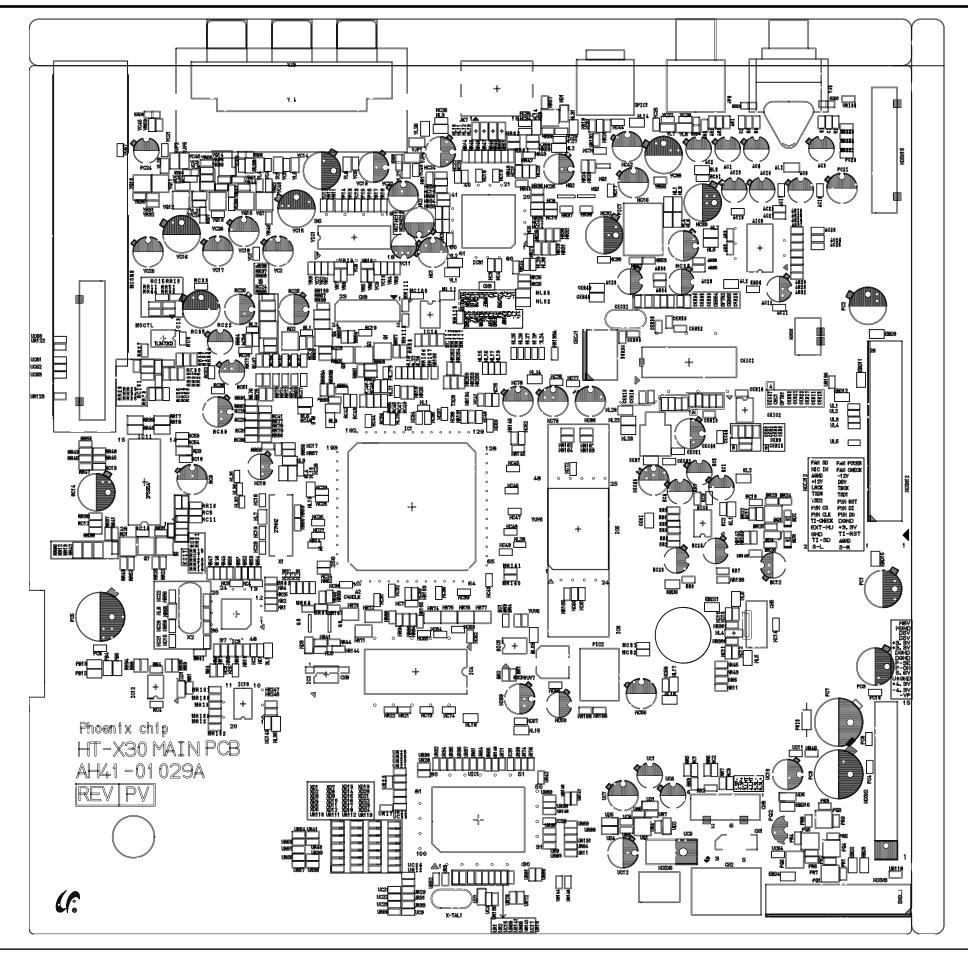
Samsung Electronics 10-1

11. PCB Diagram

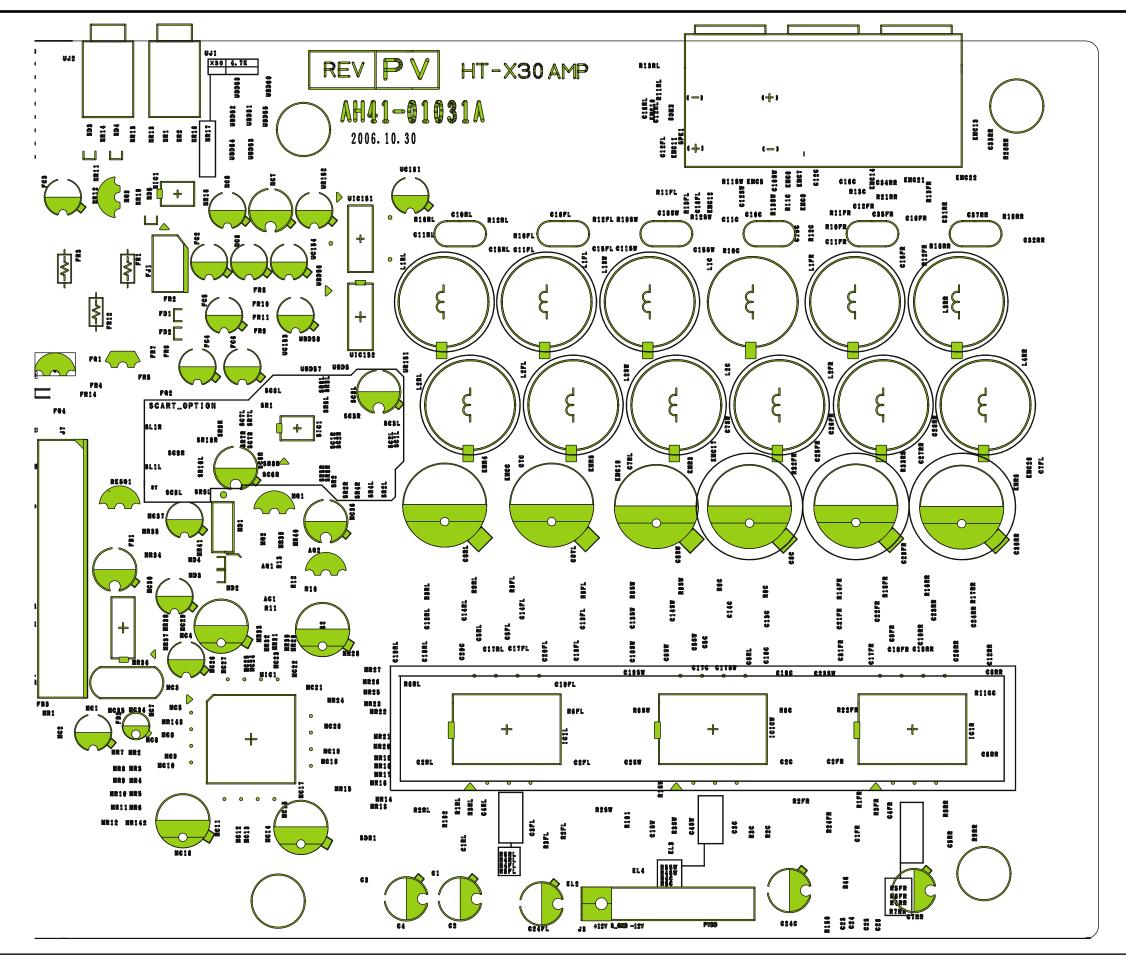
1. PCB FRONT



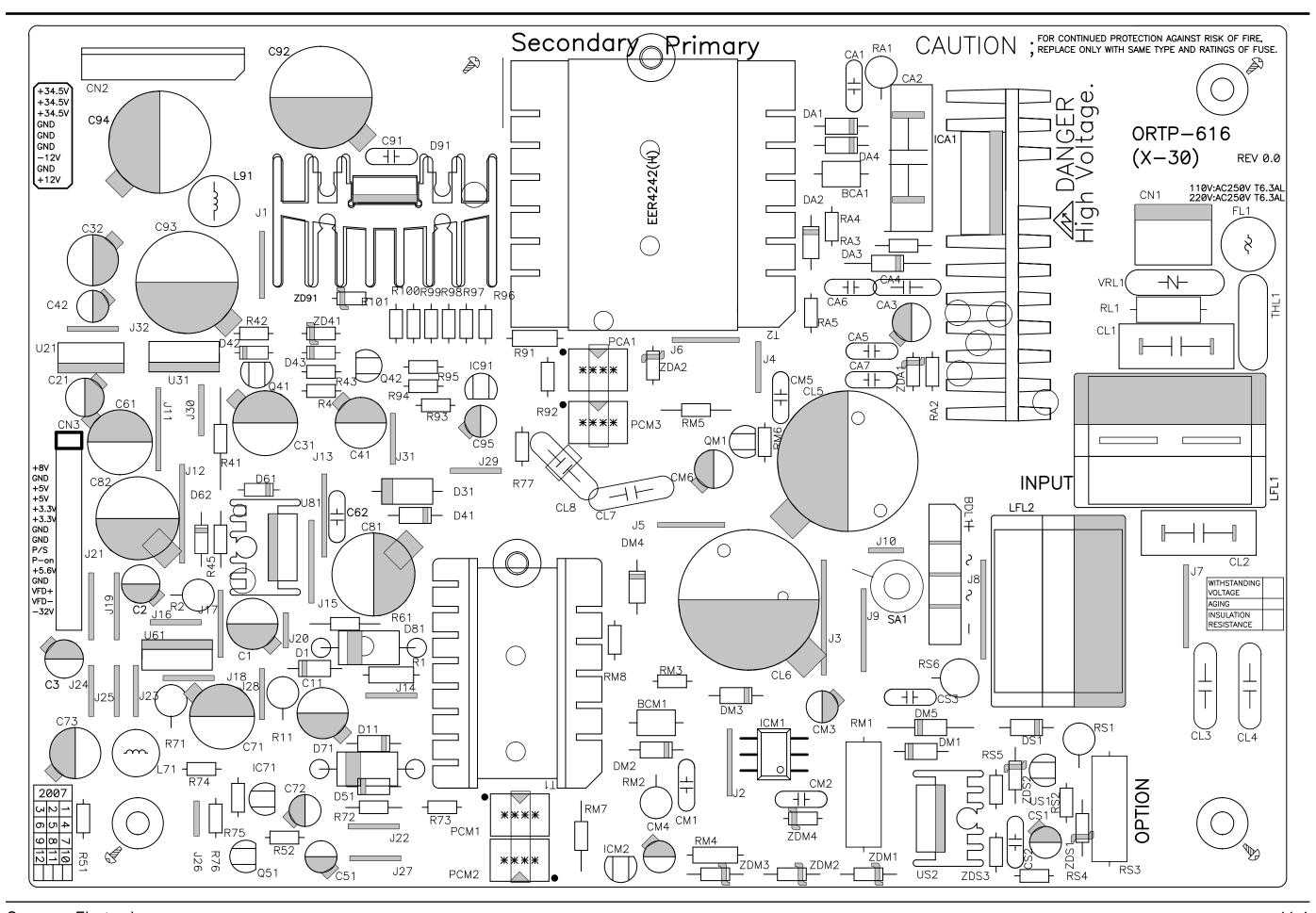
11-1 Samsung Electronics



Samsung Electronics 11-2

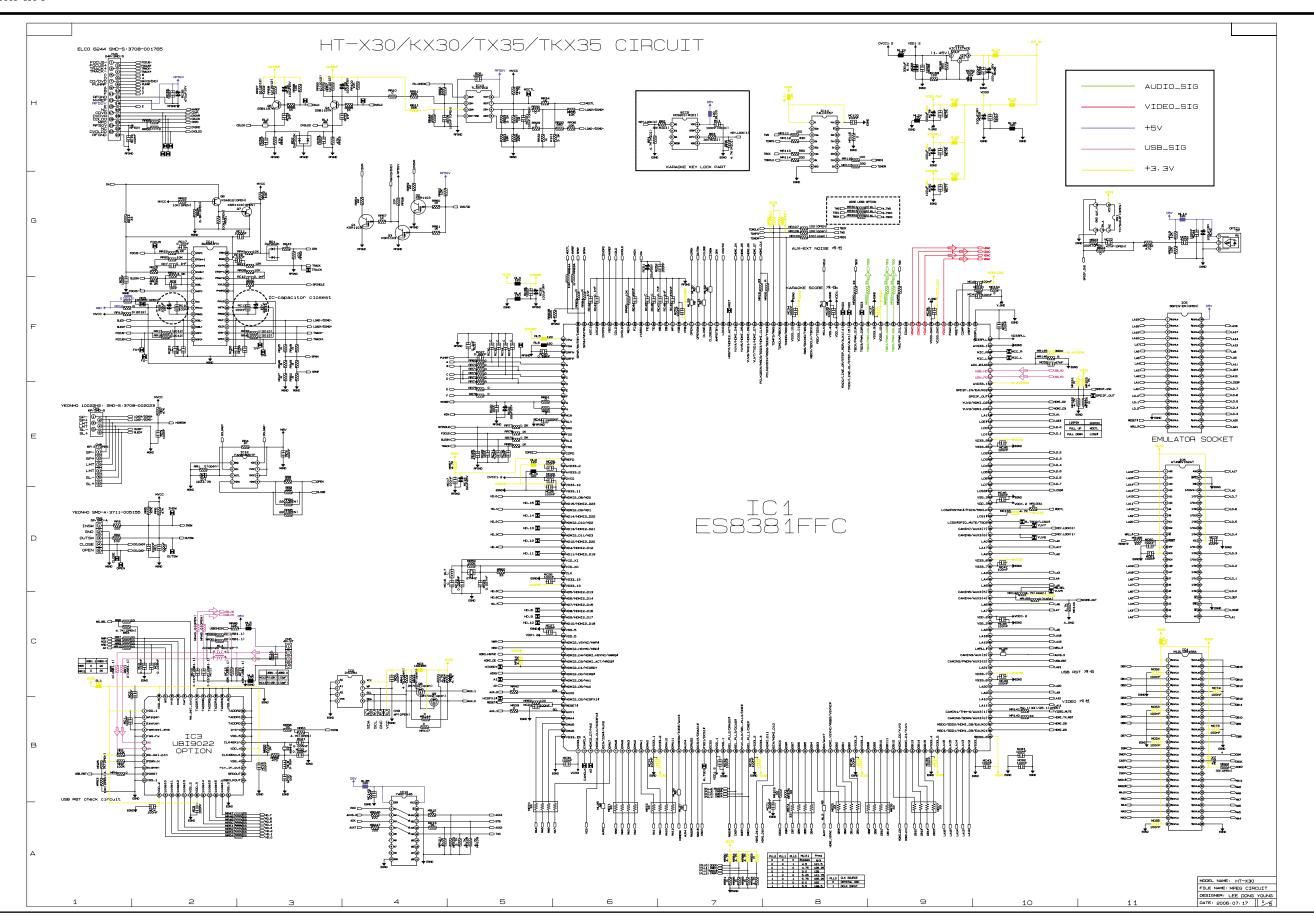


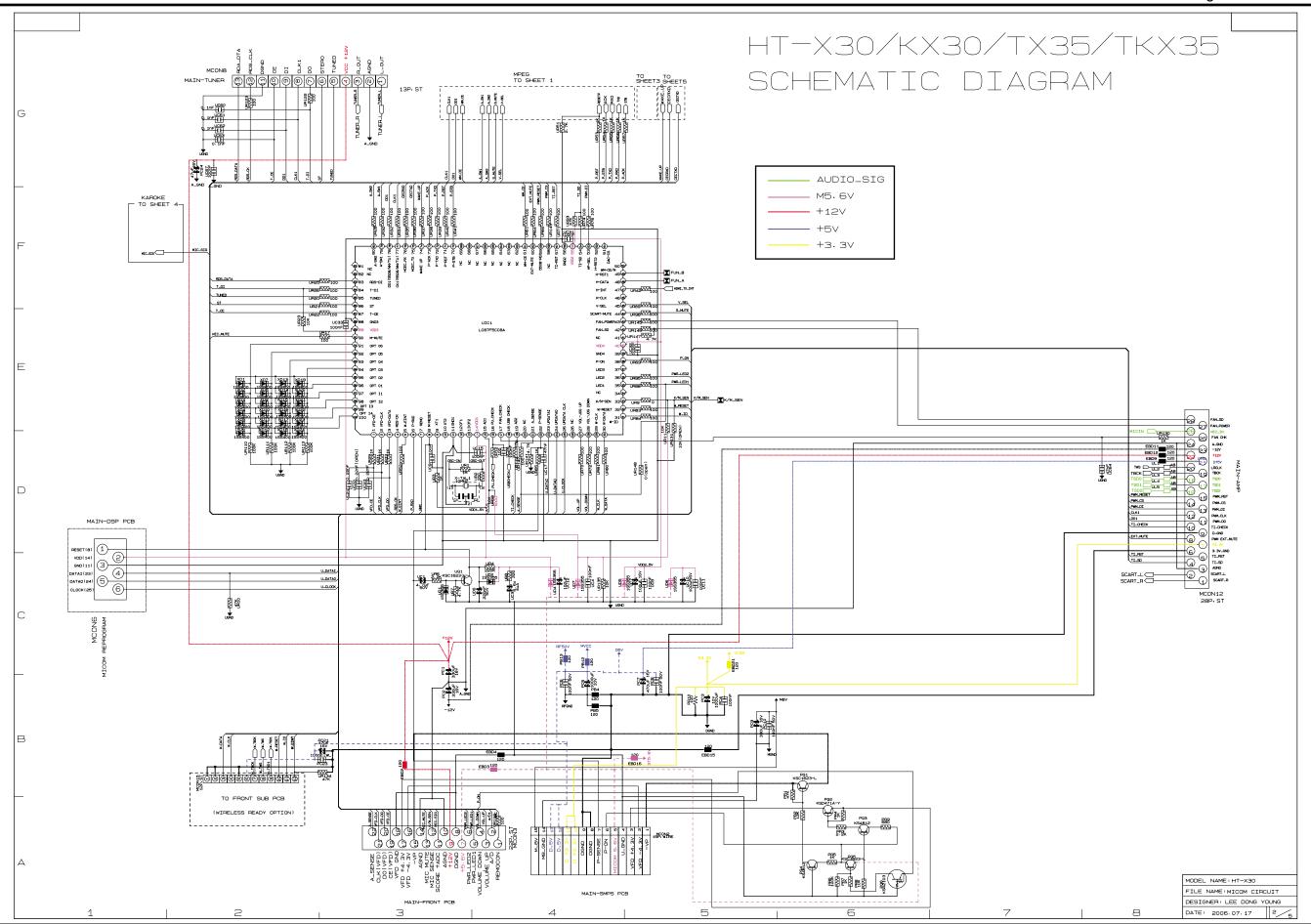
11-3 Samsung Electronics

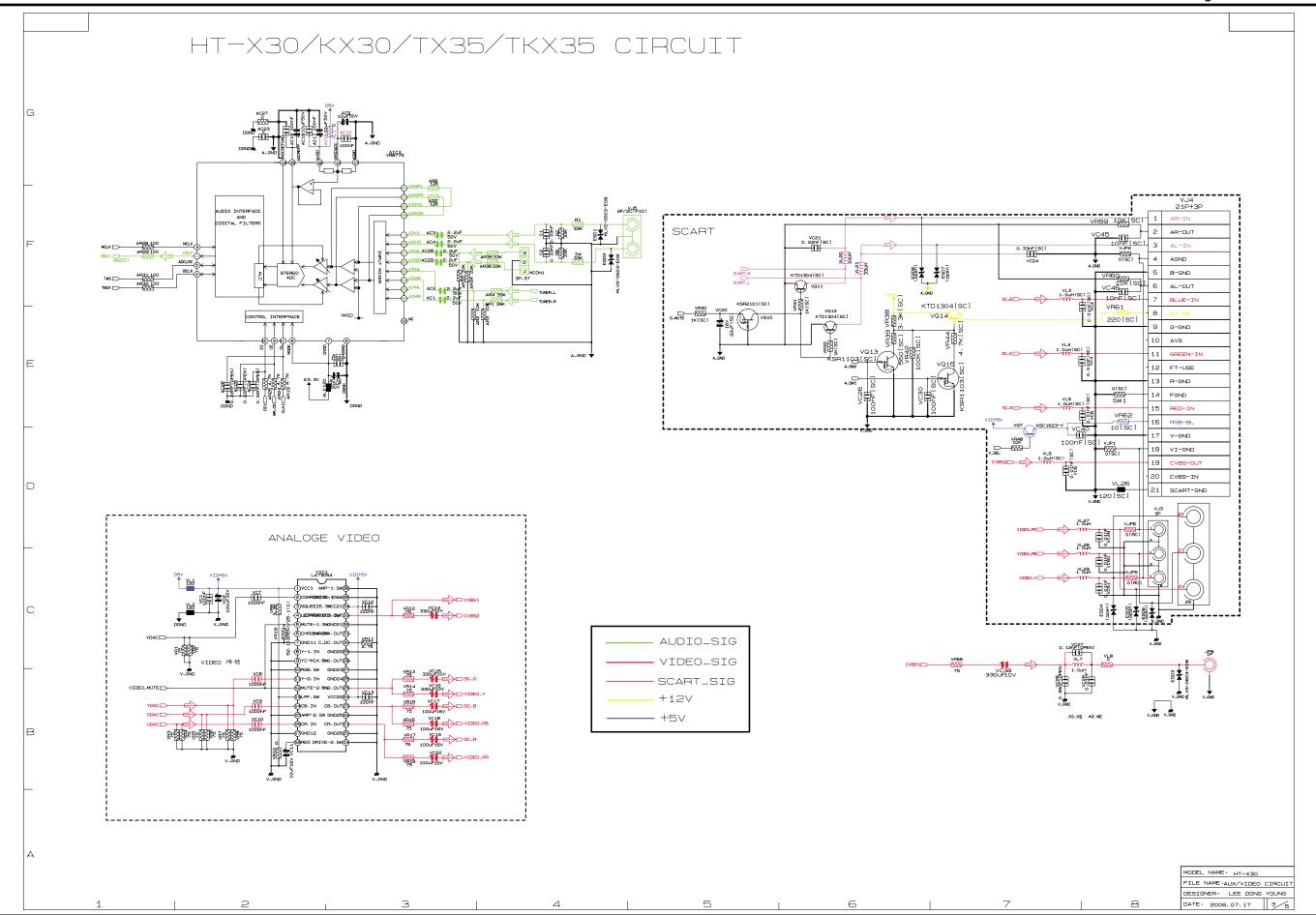


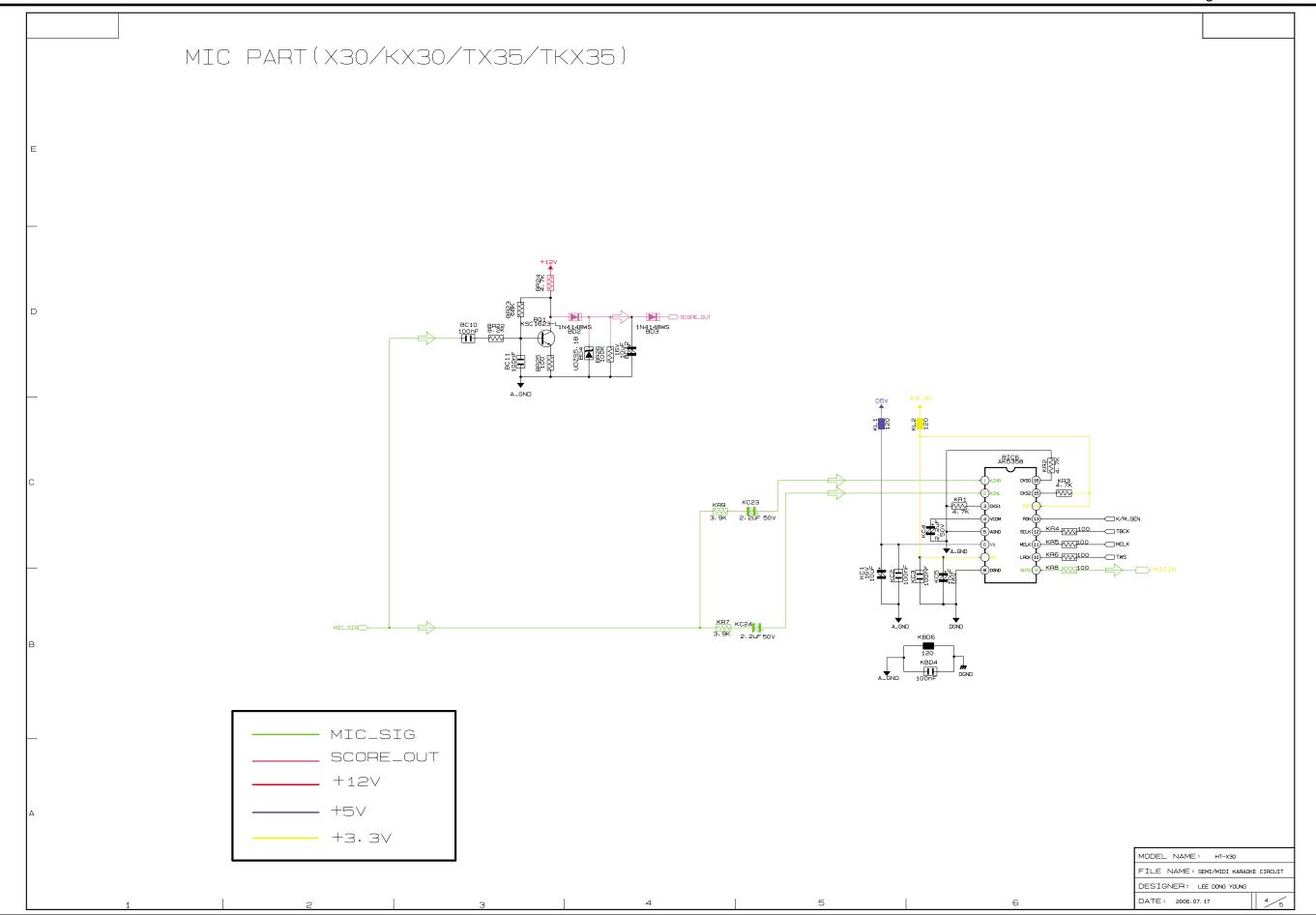
Samsung Electronics 11-4

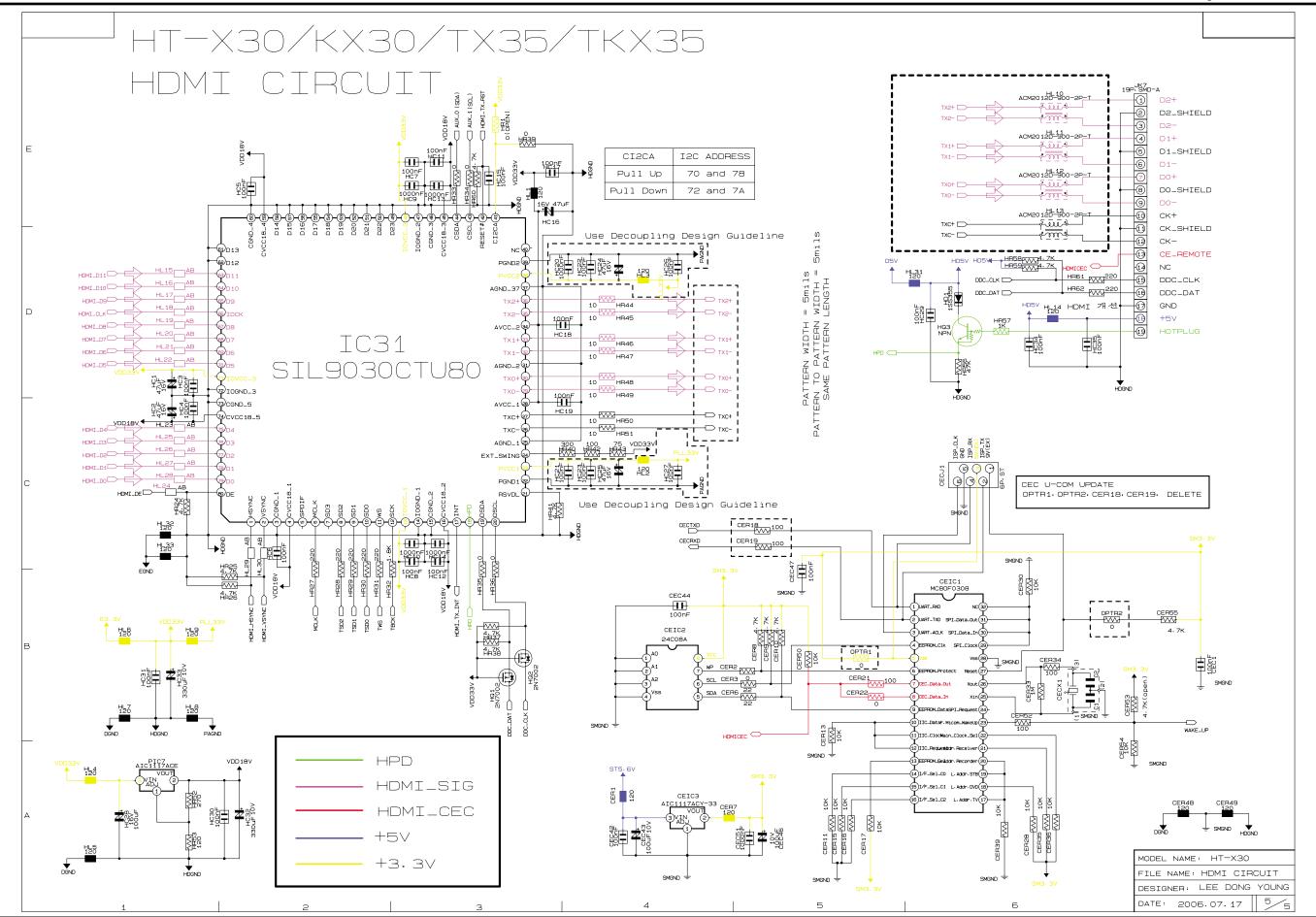
1-1. MAIN

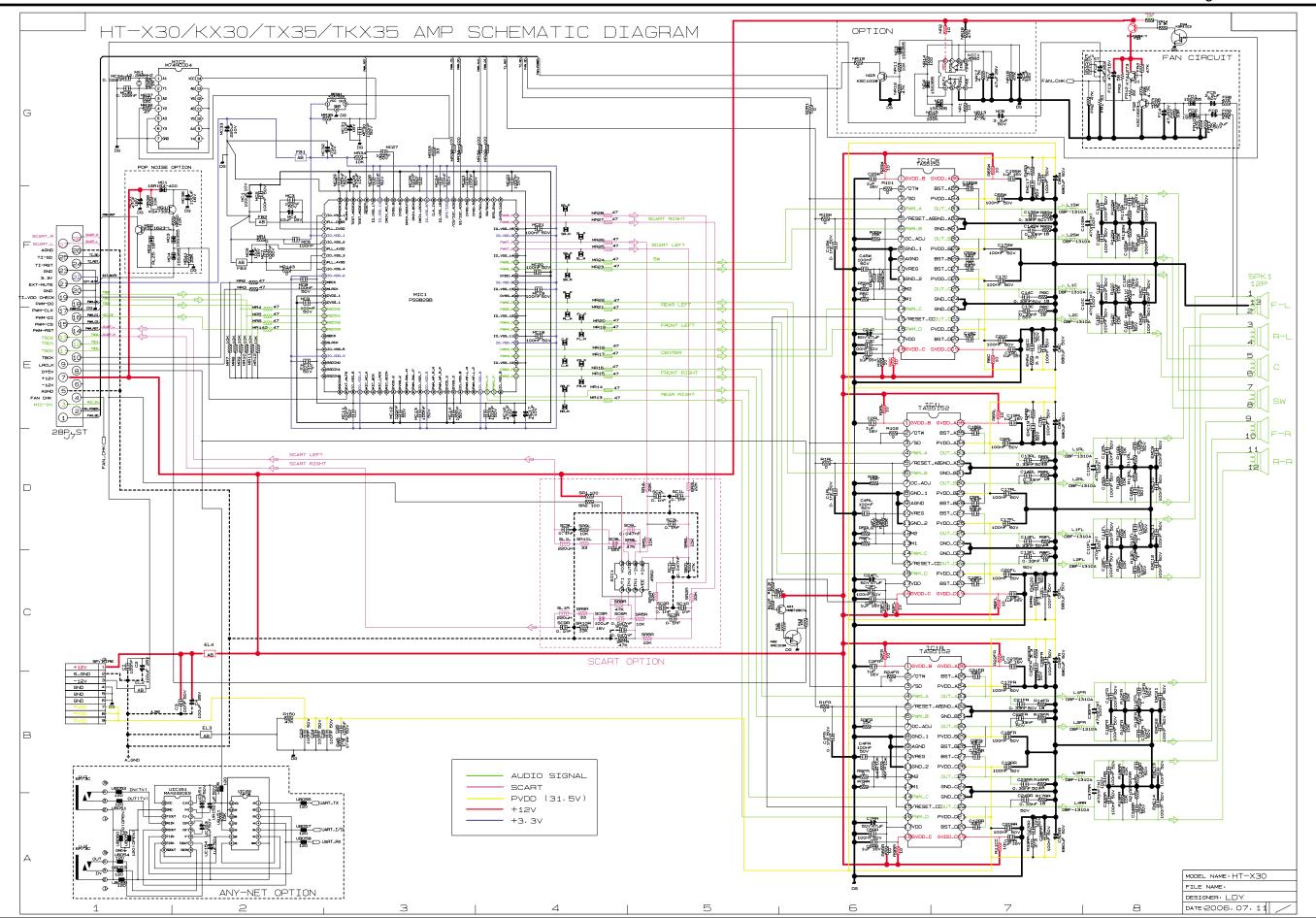


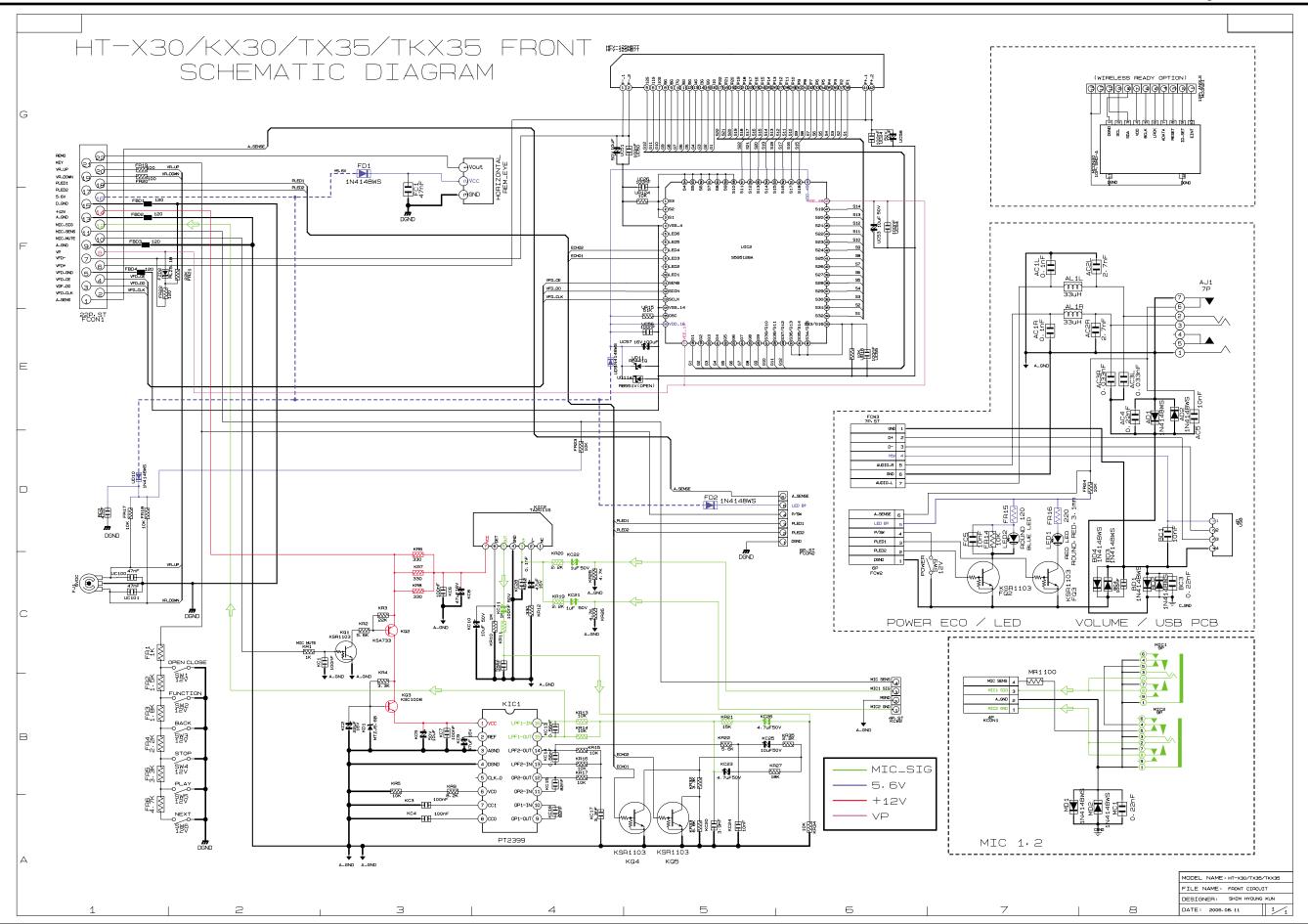


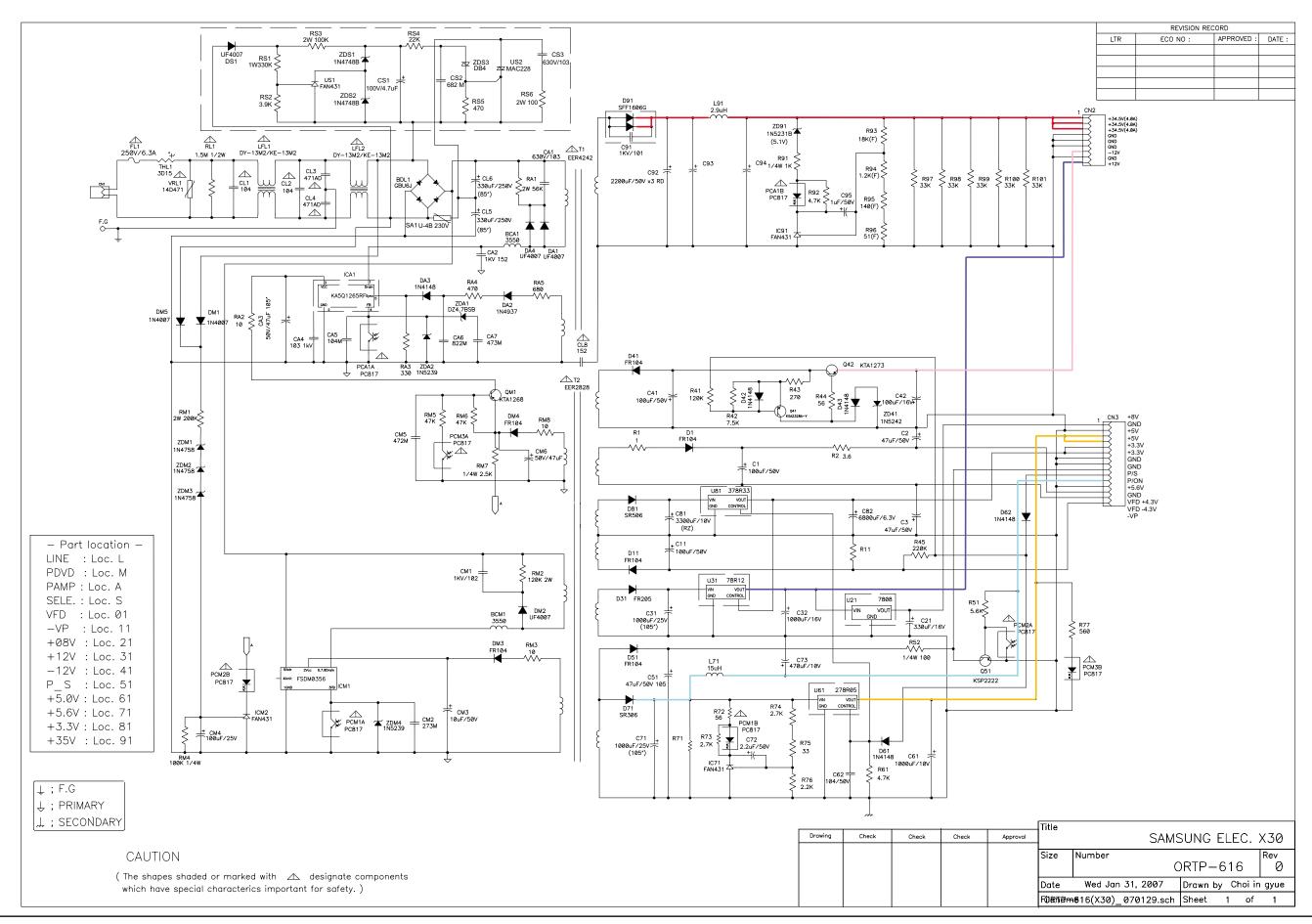








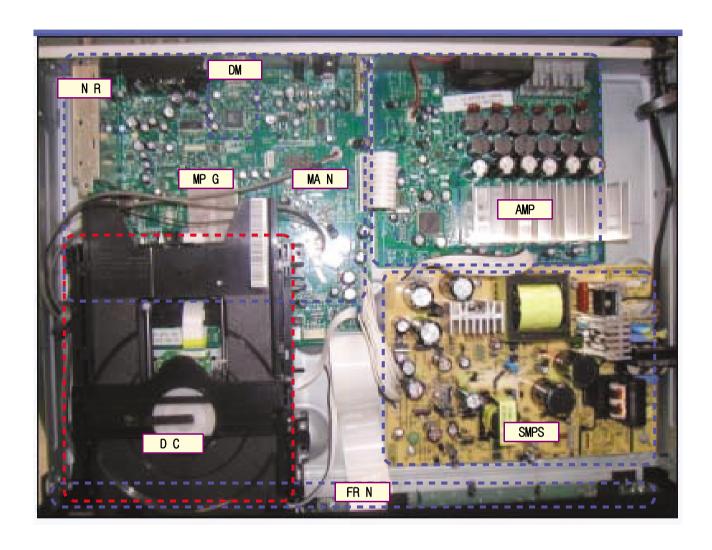




Samsung Electronics

13. Circuit Board Description

1. Circuit Layout and Functions (HT-X30)



13-1 Samsung Electronics

2. The Functions of each Board

Blo k ype	Main Fun ions	Remarks
SMPS	AC Po er erminal and M C M Po er - he po er supplied ia he AC ord is ransferred o he Main Po er rans ia Pro e ion Cir ui s Fuse aris or e . in SMPS S and-ysae. - When he AC ord is onne ed o an oule S and-y drie po er is supplied from SMPS o he Main Se for normal operation upon poer-on. Conne or Spe ifiations M: he C poer had ries he pen/Close of he M C A ray and Roule e / P-S NS: A erminal hauses Poer-Sense odee he her he AC ord is onne ed o an oule. he S NS erminal should ese o in order oere ognied y M C M for poer-on of he S Approx. 5. P/ N: f he P W R-N erminal dees P/S NS in M C M and poers on he S his poer dries SMPS osupply all poer ohe Main M C M and FD Drier C and urns on he Red D Approx. 5. P: he negated rie poer for he FD Drier C Approx3 FDDC: Drie Poer for he Filamen in FD Approx. for eah erminal upon poer-on D 5: M C A Digital Poer AD Con er er WM 5 Drie Poer	- F S F1 : A - AR S R R1 :10D 1

Blo k ype	Main Fun ions	Remarks
MA N-PCB	Main M C M Se ion - 10 M silla or - C : Shared y PS B WM 5 and uner. - Da a: Shared y PS B WM 5 S5G51 A and uner. a k PCB Se ion Con rol Se ion rela ed o arious ideo - npu : Audio 1 / Digi al N - u pu : Composi e / Componen /P /Pr e . DM Con rol C C Se ions - S 1 0 X- C MC OFO3 M C M	
FR N -PCB	Fron PCB Se ion - Con rols opera ion of he fron panel in luding FD dri e and D opera ion R M C N opera ion and Body eys opera ion. FD and FD Dri er C Cir ui - urns on he Red D upon s and- y and he Blue D upon po er-on. - Configures o her AD ir ui s s i hes. olume Cir ui - urns on he olume Blue D upon po er-on and opera es he Dimmer n/ ff Remo on.	

Samsung Electronics 13-2

Blo k ype	Main Fun ions	Remarks
AMP-PCB	AMP Dri e Se ion - he 1 S da a from he MP G is inpu o he Modula or rou ed for PWM u y hannel and hen for analog ou pu ia he AMP C in he Full Bridge me hod. - mplemen s hannels of 133 W per a single AS515 C. Pro e ion Cir ui - De e s an a normal eha ior in ea h AMP C and sends an aler o he -SD M C M Por A i e o . - Pro e ion pera ion ypes Shor Cir ui: When a shor ir ui o urs e een /- SP u pus or e een SP u pus and Chassis. C er-Curren Pro e ion: When ex essi e urren is indued o u pu. er-empera ure Pro e ion: f he empera ure of he C un ion ex eeds 155 i should e kep ypi ally elo 15. o e er his op ion is no ena led no. nder- ol age Pro e ion: Should e kep a o e he P hreshold. Fan Dri e Se ion - Si e: RDM5015S - o -le el pera ion: pon po er-on 1 po er is issued o opera e he Fan a lo le el. Fan Dri e ol age: Approx5 Fan Speed: Approx. 3 RPM Max.	
MP GP-PCB	MPGDrie Se ion - S31 - mplemen sDP DS DD and DD-AD.	

13-3 Samsung Electronics